

TOSHIBA MOS TYPE DIGITAL INTEGRATED CIRCUIT TMP47C40P, TMP47C41P TMP47C20P, TMP47C21P SILICON MONOLITHIC SILICON GATE CMOS

CMOS 4-BIT SINGLE CHIP MICROCOMPUTER (TLCS-47C) TMP47C40P, TMP47C20P, TMP47C41P, TMP47C21P

GENERAL DESCRIPTION

The TLCS-47 is the high speed and high performance, 4-bit single chip microcomputer series designed for the general purpose use.

The TLCS-47 has variously powerful functions in order to meet with advanced and complicated applications, which will be made in near future. In addition, software compatible NMOS family (TLCS-47N) and CMOS family (TLCS-47C) are also provided.

The TMP47C4OP and TMP47C2OP are the standard chips for the TLCS-47C. These chips are similar to each other, except memory capacity. And in the case of high breakdown voltage output type, production part's number is TMP47C41P or TMP47C21P. The TMP4700C (NMOS) is an evaluator chip used for the system development.

Part No.	ROM (Bit)	RAM (Bit)
TMP47C40/41P	4,096 × 8	256 × 4
TMP47C20/21P	2,048 × 8	128 × 4
TMP4700C	Externally provided (4,096 × 8)	256 × 4



TMP47C40P, TMP47C41P

TMP47C20P, TMP47C21P



TECHNICAL DATA

FEATURES

•	4-bit single chip microcomputer with built-in ROM, RAM, input/output port, divider, timer/counter, and serial port.
•	Instruction execution time: $4\mu s$ (at 4 MHz clock)
•	Effective instruction set 90 instructions, software compatible in the series
•	Subroutine nesting: Maximum 15 levels
•	6 interrupts (External: 2, Internal: 4) Independently latched control and multiple interrupt control
•	Input/output port (35 pins)
	Input1 port4 pinsOutput (corresponding to PLA)2 ports8 pinsI/04 ports16 pinsI/0 (Note)2 ports7 pins
	Note: These $I/0$ ports are also used for the interrupt input, timer/
	counter input, and serial port; therefore, it is programmably
	selectable for each application.
•	PLA data converting function (Instruction) Output of data to output port (8-bit)
•	Table look-up and table search function (Instruction) Table can be set up in the whole ROM area.
•	<pre>12-bit timer/counter (2 channels) Event counter, timer, and pulse width measurement mode is programmably selectable. Serial port with 4-bit buffer Receive/transfer mode is programmably selectable. External/internal clock and leading/trailing edge mode are programmably selectable.</pre>
•	18-stage divider (with 4-stage prescaler) Frequency applied for timer interrupt of divider is programmably selectable.
•	High breakdown voltage output (20 pins) Maximum rating 42V, FL tube direct drive is available.
•	Hold function Battery operation/condenser backup is available.
•	On chip oscillator
•	TTL/CMOS compatible
•	+5V single power supply
•	42-pin DIL plastic package
,	Si-gate CMOS LSI

TMP47C40P, TMP47C41P

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TECHNICAL DATA

TMP47C20P, TMP47C21P



PIN CONNECTIONS (Top View)

R40 1	42 0 V _{DD}
R41 2	41 R92 (SCK)
R ₄₂ C 3	40 0 R ₉₁ (SO)
R ₄₃ ¢ 4	39 P R ₉₀ (SI)
R ₅₀ C 5	38 R ₈₃ (T1)
R ₅₁ q 6	37 R ₈₂ (INT1)
R52 7	36 R ₈₁ (T2)
R53 4 8	35 P R ₈₀ (INT2)
R ₆₀ 9 9	34 HOLD
R ₆₁ q 10	33 RESET
R ₆₂ 4 11	32 2 X _{OUT}
R ₆₃ 4 12	31 0 X _{IN}
R70 4 13	30 D TEST
R71 4	29 9 K _{O3}
R ₇₂ C 15	28 D Koo
R73 4 16	27 P Kol
P ₁₀ 4 17	26µ K ₀₀
P ₁₁ 4 18	25 P P ₂₃
P ₁₂ [19	24] P22
P ₁₃ 0 20	23 p P ₂₁
v _{DD} q 2 1	22 9 P ₂₀

PIN NAMES AND PIN DESCRIPTION

Pin Name	No. of pins	Input/Output	Function		
$K_{o 3} \sim K_{o o}$	4	Input	Input port		
$P_{13} \sim P_{10}$	4	Output	Output port (Corresponding to PLA)		
$P_{23} \sim P_{20}$	4	Output	" (")		
$R_{43} \sim R_{40}$	4	I/0	I/O port		
$R_{53} \sim R_{50}$	4	I/0	11		
$R_{63} \sim R_{60}$	4	1/0	11		
$R_{73} \circ R_{70}$	4	I/0	TI		
R ₈₃ (T1)	R ₈₃ (T1) 1 1		I/O port or timer/counter input		
R ₈₂ (INT1)	1	I/0	I/O port or interrupt input		
R ₈₁ (T2)	1	I/O	I/O port or timer/counter input		
R _{so} (INT2)	1	1/0	I/O port or interrupt input		
R ₉₂ (SCK)	1	I/0	I/O port or shift clock for serial port		
R ₉₁ (SO)	1	I/0	I/O port or serial output		
R ₉₀ (SI)	1	I/O	I/O port or serial input		
X _{IN} , X _{OUT}	2	Input,Output	Resonator connection terminals		
RESET 1		Input	Initialize signal input		
HOLD 1 Input		Input	Hold signal input		
TEST	1	Input	(Low level is input.)		
VDD	1	Power Supply			
VSS	1	Power Supply	ov		

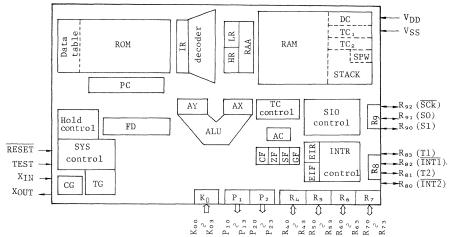


TMP47C40P, TMP47C41P TMP47C20P, TMP47C21P PREI MINARY



TECHNICAL DATA





BLOCK NAMES AND DESCRIPTION

Block Name	Function
PC	Program counter (12 bits)
ROM	Program memory (including fixed data)
IR, decoder	Instruction register, Decoder
HR, LR	H register (page assignment of RAM), L register (address assignment in RAM page), (each 4-bit register)
RAA	RAM address buffer register (8 bits)
RAM	Data memory
STACK	Save area of program counter and flags (RAM area)
SPW	Stack pointer word (RAM area)
DC, data table	Data counter (12 bits, RAM area), Data table (ROM area).
AX, AY	Temporary register of ALU input
ALU	Arighmetic and logic unit
AC	Accumulator
FLAG (CF,ZF,SF, GF)	Flags
K, P, R	Ports
INTR control	Interrupt control
	(EIF: Enable interrupt master F/F, EIR: Enable interrupt
	register)
FD	Frequency divider (4-stage prescaler + 18 stages)
TC_1 , TC_2	12-bit timer/counter 2 channels (RAM area)
TC control	Timer/counter control
SIO control	Serial port control
HOLD control	Control for hold function
SYS control	Generation of various internal control signals
CG, TG	Clock generator, Timing generator





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FUNCTIONAL DESCRIPTION
1. System Configuration
   1. Program Counter (PC)
   2. Program Memory (ROM)
   3. H Register (HR), L Register (LR), RAM Address Buffer Register (RAA)
   4. Data Memory (RAM)
      (1) Stack (STACK)
      (2) Stack Pointer Word (SPW)
      (3) Data Counter (DC)
   5. ALU, Accumulator (AC)
   6. Flags (FLAG)
   7. Ports (PORT)
   8. Interrupt Control Circuit (INTR)
   9. Frequency Divider (FD)
  10. Timer/Counter (TC1, TC2)
  11. Serial Port (SIO)
  12. Hold Control Circuit (HOLDC)
 Concerning the above component parts, the configuration and functions of
 hardwares are described :
 Hexadecimal notation is used for the description, charts, and tables in order
  to indicate the address and the like, without assigning identification symbols
  as far as it does not give rise to confusion.
         The following names and symbols are used unconsciously.
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(a)	CPU	Control Processing Unit except for the built-in peripheral
		circuitry, such as interrupt control circuit, timer/counter,
		and serial port.

- (b) CP Clock pulse generated in the clock oscillator. It is called the "basic clock" or merely "clock".
- (c) fc Indicates the frequency of the clock oscillator, namely, the frequency of the basic clock.
- (d) MSB/LSB Indicates Most/Least Significant Bit.
- (e) F/F Indicates Flip/Flop.





1.1 Program Counter (PC)

It is a 12-bit binary counter, and the contents of the program counter indicate the address of program memory in which the next instruction to be executed is stored.

The program counter generally gains increment at every instruction fetch by the number of bytes assigned to the instruction. However, when executing the branch and subroutine instructions or receiving the interrupt, the values specified by these instructions and operation are set. Value "0" is specified by initializing the program counter.

The page structure of program memory is made with 64 words per page. The TMP47C40P has 64 pages and the TMP47C20P 32 pages.

At the execution of (BSS a) instruction, the value assigned by the instruction is set in the lower 6 bits of the program counter when the branch condition is met. That is, the (BSS a) instruction is used as a branch or jump instruction within a page. If the (BSS a) instruction is stored in the last address of the page, the value in the higher 6 bits of the program counter indicates that the branch or jump instruction to the next page is executed.

At the execution of (CALL a) instruction, the value specified by the instruction is set in the program counter after the previous contents of the program counter has been saved in the stack. Since 11 bits are of the address bit length which can be assigned by the instruction, the call address of subroutine should be in the range of addresses 000 - 7FF.

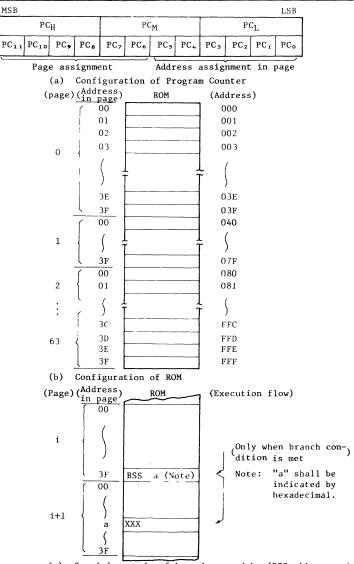


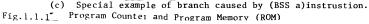




TECHNICAL DATA

MSB









1.2 Program Memory (ROM)

Processing programs and fixed data are stored in the program memory. The next instruction to be executed is read out from the address indicated by the contents of the program counter.

The fixed data stored in the program memory can be read by using the ROM data referring instruction or the PLA referring instruction. The ROM data referring instruction reads out the higher or lower 4-bit data of the fixed data stored in the address decided by the data counter [(LDH A, @DC+) and (LDL A, @DC) instruction respectively], and stores the data in the accululator. The PLA referring instruction (OUTB @HL) reads out the fixed data (8-bit) stored in the address decided by the contents of the data memory indicated by the contents of H and L registers as well as contents of the carry flag, and outputs the data to output ports (P2 · P1).

Addresses are individually assignged to the program memory and data memory, so that the fixed data in the ROM area cannot be directly read out by the address of the data memory.

Specific Addresses of Program Memory

The following addresses of the program memory are used for specific purposes. When not used for these purposes, the specific addresses can be used to store the processing programs and fixed data.



TECHNICAL DATA

TMP47C40P TMP47C20P



Specific Address	Specific Purposes
000 (001)	Start address by initialization
002 (003)	INT1 Interrupt vector address
004 (005)	ISIO Interrupt vector address
006 (007)	IOVF1 Interrupt vector address
008 (009)	IOVF2 Interrupt vector address
00A (00B)	ITMR Interrupt vector address
00C (00D)	INT2 Interrupt vector address
8n+6 (n=1~15) 086 (Note)	Call address by instruction (CALLS a)
FEO 2 FFF	PLA data conversion table

Note : 086 (hexadecimal) = 134 (decimal)

Table 1.2.1 Specific Address of Program Memory



TECHNICAL DATA

TMP47C40P TMP47C20P PREIMINARY

ROM CAPACITY

The TMP47C40P and TMP47C20P contain a program memory with 4,096 \times 8-bit (addresses 000 - FFF) capacity and 2,048 x 8-bit (addresses 000 - 7FF) capacity, respectively. But the TMP47C20P contains a program counter with 12-bit length. Therefore, when one of addresses 800 - FFF is accessed in a program, the ROM data corresponding to addresses 000 - 7FF read out. It is because there is no physical ROM in addresses 800-FFF, but the MSB in the program counter is not decoded. For example, when the data located in address FF3 is output to a port by the PLA referring instruction on a program, the data located in addresses 7F3 is read out. In the TMP47C20P, the PLA data conversion table (addresses FE0 - FFF) is, therefore, located in addresses 7E0 - 7FF.

"0" [(NOP) instruction] is read out for the ROM data within the range of the built-in ROM capacity, if it is not specified by the user.

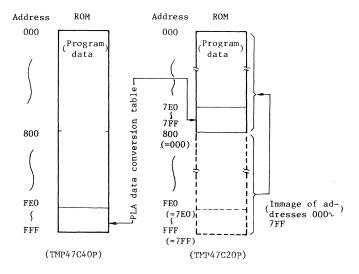


Fig. 1.2.1 ROM Capacity and Address





1.3 H Register (HR), L Register (LR), and RAM Address Buffer Register (RAA)

The H and L registers are 4-bit registers used as the data memory address pointers or general purpose registers.

The page structure of the data memory is based on 16 words per page. Pages are specified by H register, and addresses in page are done by L register, respectively. TMP47C40P has 16 pages and TMP47C20P 8 pages.

The L register is also used to specify the bits corresponding to pins $R_{73} \sim R_{40}$ of the I/O port when instructions (SET @L), (CLR @L), and (TEST @L), are executed.

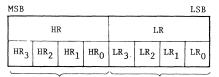
The RAM address buffer register is a temporary register used to specify the address in the data memory, and serves as an input of the RAM address decoder. Normally, the data specified by the contents of the H and L registers or immediate data of an instruction is fed into the RAM address buffer register.



TMP47C40P TMP47C20P



TECHNICAL DATA



Page specification Address specification in page

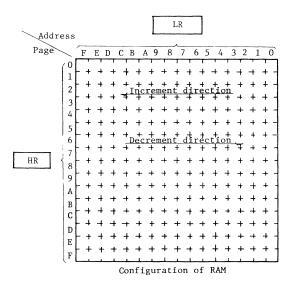


Fig. 1.3.1 H Register, L Register and Data Memory (RAM)







1.4 Data Memory (RAM)

The processing data of user are stored in the data memory. The data is read out or written in according to the address indicated by the contents of the RAM address buffer register.

Specific addresses of data memory

The data memory is also used for the following specific purposes. When it is not used for the respective purposes, the RAM of the corresponding address can be used to store the user processing data.

- (1) Stack (STACK)
- (2) Stack pointer word (SPW)
- (3) Data counter (DC)
- (4) Timer/Counter (TC1, TC2)
- (1) Stack (STACK)

The stack, which is contained in the data memory (one level of the stack consists of 4-word RAM), is area to save the contents of the program counter (return address) and flag prior to jumping to the processing program at time of subroutine call or interrupt acceptance. To return from the processing program, (RET) instruction is used to restore the contents saved in the stack to the program counter, and (RETI) instruction is used to restore the contents saved in the stack to the program counter and flags.

The location of the stack to save/restore the contents is determined by the stack pointer word, which is automatically decremented after the saving operation, and incremented prior to the restoring operation.





(2) Stack Pointer Word (SPW)

The address FF in the data memory is called a stack pointer word and decides the stack pointer. The stack is contained in the RAM, and accessed by the stack pointer.

The stack pointer is decided with the format shown in Fig. 1.4.1, but this address indicates the lower RAM address in each level of the stack.

Values "E" - "0" can be assigned for the stack pointer word, so that the maximum of 15 nesting levels are available for the stack. However, when the timer/counter mentioned following is used, the level containing the RAM address corresponding to the timer/counter cannot be used for the stack (value "F" is not assigned to the stack pointer word, because the stack contains the RAM address corresponding to the stack pointer word). The stack pointer word is automatically updated by the subroutine call or interrupt acceptance; however, it cannot exceed the allowable size of the stack for the system configuration.

Since the stack pointer word is never initialized in terms of hardware, it is necessary to set it to the highest possible level of the stack in the user's initialization prpgram. For instance, it is set to "C" level when the two channels of timer/counter are used.

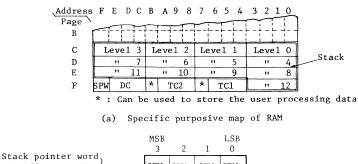
Note: The "level" indicates the depth of the nesting in the stack as well as the location of the next available stack. That is, it represents the contents of the stack pointer word.

TMP47C40P TMP47C20P



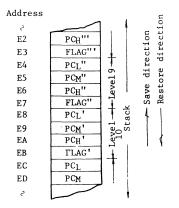


TECHNICAL DATA



(RAM address : FF)		SPW₃	SPW2	SPW1	SP₩₀			
	MSB			·				LSB	
	7	6	5	4	3	2	1	0	
(Stack pointer)	1	1	SPW₃	SPW 2	SPW1	SPW₀	0	0	

(b) Stack pointer and stack pointer word



(c) Structure of stack

Fig. 1.4.1 Specific Address and Stack of Data Memory





(3) Data Counter (DC)

Data counter is a 12-bit binary counter used to specify the address when the data table in the ROM area is referred (ROM data referring instruction).

The RAM address with 4-bit unit is allocated to the data counter, so that the initial value setting and the content reading of the data counter can be executed by the RAM manipulative instructions.

	MSB			LSB
		D	С	
(Data Counter)	DCH	DCM	DCL	
(RAM Address)	(FE)	(FD)	(FC)

Fig. 1.4.2 Data Counter and RAM Address

(4) Timer/Counter (TC1, TC2)

The two channels of 12-bit timer/counter are built-in, and the RAM address with 4-bit unit is allocated to the timer/counter, so that the initial value setting and the content reading of the timer/counter can be executed by the RAM manipulative instructions.

When the timer/counter l is not used, the stack lower from level 13 can be used. When both of the timer/counter l and 2 are not used, the stack lower from level 14 can be used.

	MSB		LSB
(Timer/Counter 1)		TC1	
(IImer/Counter I)	tc1 _H	TCIM	TC1L
(RAM Address)	(F6)	(F5)	(F4)

	MSB		LSB
(Timer/Counter 2)		TC2	
(Timer, counter 2)	TC2 _H	TC2 _M	TC2L
(RAM Address)	(FA)	(F9)	(F8)

Fig. 1.4.3 Timer/Counter and RAM Address

(5) Page 0 in Data Memory

Page 0 in the data memory (addresses 00 - OF) is effectively used as a flag or pointer in a user's program.



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RAM Capacity

Data memory contained in TMP47C46P has a 256×4 -bit (addresses 00 - FF) capacity, and that contained in TMP47C20P has a 120×4 -bit (addresses 00 - 7F) capacity.

Since the TMP47C2OP also has the RAM address buffer register of 8-bit length, there is no physical RAM in addresses 80 - FF in the TMP47C2OP. However, the RAM equivalent to addresses 00 - 7F are referred when addresses 80 - FF are accessed in a program, because the MSB of RAM address buffer register is not decoded. That is, the specific RAM address is distributed to C0 - FF in a program, but the RAM equivalent to addresses 40 - 7F are assigned in the T4P47C2OP.

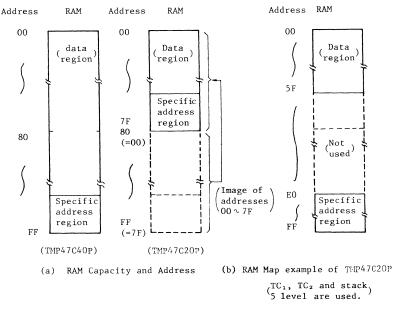


Fig. 1.4.4 RAM Capacity and Address



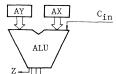
TMP47C40P TMP47C20P PRELIMINARY

TECHNICAL DATA

1.5 ALU, Accumulator (AC)

The ALU is a circuit used for various arithmetic and logical operation for 4-bit binary data. It performs the operation designated by the instruction, and outputs the 4-bit result, carry (C), and zero detection signal (Z).

The accumulator is a 4-bit register to use a source operand for the arithmetic operation, and in which the result is stored.



 $C \longrightarrow (AX and AY are temporary registers.)$

Output of result

MSB LSB 2 0 (Accumulator)

Fig. 1.5.1 ALU, Accumulator

Detection of operating condition

Output C from the ALU indicates the carry output from the most significant position in the addition operation. However, the subtraction is executed with the addition of the 2's complement, so that output C in the subtraction operation indicates the "non-borrow" from the most significant position (i.e., in case of non-borrow, C = "1"). Accordingly, borrow (B) can be represented with " \overline{C} ".

Output Z indicates the zero detection signal to which "1" is applied when all of the 4-bit data transferred to accumulator or output of the ALU are cleared to zero.





TECHNICAL DATA



Example (4-bit operation)

(a)	4 + 5 = 9	(C = 0, Z = 0)
(b)	7 + 9 = 0	(C = 1, Z = 1)
(c)	3 - 1 = 2	(B = 0, Z = 0)
(d)	2 - 2 = 0	(B = 0, Z = 1)
(e)	6 - 8 = -2 or E	(B = 1, Z = 0)

Note : $B = \overline{C}$ is indicated.

1.6 Flag (FLAG)

Flag is a 4-bit register used to store the condition of arithmetic operation, and of which the set/reset conditions are specified by the instruction. The flag consisting of CF, ZF, SF, and GF is saved in the stack when the interrupt is accepted. By executing the (RETI) instruction, it is restored from the stack to the conditions immediately before the interrupt is accepted.

 3	2	1	0
CF	ZF	SF	GF

Fig. 1.6.1 Flag

(1) Carry Flag (CF)

This flag is used to hold the carry in the addition operation as an input to the ALU by the (ADDC A, @HL) instruction as well as to hold the non-borrow in the subtraction operation (the carry in the addition of the 2's complement) as an input to the ALU by the (SUBRC A, @HL) instruction. The rotate instruction makes the flag hold the data shifted out of the accumulator.





(2) Zero Flag (ZF)

This flag is stored the zero detection signal (Z) when the instruction designate to change. "1" is set if all 4 bits are cleared to zero by an arithmetic operation or data processing.

(3) Status Flag (SF)

This flag is set or reset according to the condition specified by the instruction. With the exception of particular cases, it is usually presented at every execution of an instruction, and holds the contents of the result during execution of the next instruction. It is normally set to "1", but is reset to "0" for a time under the certain condition (it varies according to the instruction, for examples, when the result is zero, when carry occurs in the addition, or when borrow occurs in the subtraction, the flag is reset).

The status flag is referred to as branch condition in a branch instruction. The memory location is branched when this flag is set to "1"; therefore, normally the branch instruction can be required as "unconditional jump instruction". On the contrary, the instruction becomes a "conditional instruction" if it is executed immediately after loading the instruction to set/reset the status flag according to the condition determined by some previous instruction.

The status flag is initialized to "1" at initialization, and is also set to "1" after the contents have been saved in the stack when the interrupt is accepted. The contents saved in the stack is restored by the (RETI) instruction.

(4) General Flag (GF)

This is a single-bit general purpose flag, being set or reset, and also used in a test by a program. This can be used for any purpose in the user program.







1.7 Port (PORT)

Data transfer to/from the external circuitry, and command/ status/data transfer between the built-in periferal circuitry are carried out by the input/output instructions.

- (a) Input/Output port : Data transfer to/from external circuitry.
- (b) Command/data output : Control of circuitry of built-in peripheral circuitry, and output of data.

(c) Status/data input : Input of status signal^(Note) and data from the built-in peripheral circuitry.

Note : Status signal is provided from serial port and hold control circuit, and is different from the status flag (SF).

To transfer the data or to control the circuitry, each port or register is selected by designating the address (Port address) by input/output operational instructions (13 instructions) in the same way as the memory.

The port address is composed of 5 bits (addresses 0 - 31). The address to be accessed differs according to a instruction. By way of caution, the port address space is independent of the program memory address space and the data memory address space.

Every output port contains a latch in order to hold the output data. Since every input port is operated without latching, it is desired to externally hold the data to be input from the external devices till the data is completely read out, or to read the data several times to confirm the contents.

The details to specify the input/output circuit format of ports and initialization of the output latch are 2.6 (2) Input/Output Circuit Format.

-	0 1 . 1		Input/Output Instructions							
Port	Symbol	Port, Register							SET	@L
ad-	(Input/	(Input/Output)	IN %P, A	OUT A ,%P			SET%P,b	TEST %P,b	CLR	@L
dress	Output)				OUT#K,%P	OUTB @HL		TESTP%P,b	TEST	@L
00	IP00/0P00	K ₀ Input port / P ₁ Output P ₁ Output latch/ P ort	0					0		
01	IP01/OP01	P1Output latch/ port	0	0	0		0	0		
02	IP02/0P02	P ₂ " /P ₂ "	0	0	0		0	0		
03	IP03/0P03									
04	IP04/OP04	R ₄ I/O port	0	0	0		0	0	0	
05	IP05/0P05	R5 ''	0	0	0		0	0	0	
06	IP06/OP06	R6 "	. 0	0	0		0	0	0	
07	IP07/0P07	R7 "	0	0	0		0	0	0	
08	IP08/0P08	Re "	0	0	0		0	0		
09	IP09/0P09	R9 ''	0	0	0		0	0		
0A	IPOA/OPOA				I					
ОВ	IPOB/OPOB		(*) 60.	rial buffer	- registe	r (Recent	ion)			
0C	IPOC/OPOC			rial buffer						
OD	IPOD/OPOD		() Sel	LIAI DUITE	, registe	r (rransm	13310117			
0E		Status input/	0					0		
OF	IPOF/OPOF	(*) / (**)	0	0	0					
10	/OP10	/ (a)								
11	/OP11	/P2.P1 output port				0			,	
11		(8-bit output)								
12	/OP12	/								
13	/OP13									
14	/OP14	/								
15	/OP15	/	(a) Hold	l control						
16	/OP16	/		rol with t	-imor int	errupt of	divider			
17	/OP17	/		er/Counter			arviage			
18	/OP18		(C) 1100			T				
19	/OP19	/ (b)		0	I	I				
1A	/OP1A	/		er/Counter		1 .				
1B	/OP1B		(e) Ser:	ial port co	ontrol	1				
1C	/OP1C	/ (c)		0	I					
1D	/OP1D	(b) /		0						
1E	/OP1E	/								
1F	/OP1F	/ (e)		0						

396

Note 1: Inputs (IP10 - IP1F) of port addresses 10 - 1F remain undefined.

Note 2: Port addresses with "----" mark are reserved addresses and cannot be used at user's program.

Note 3: OP11 is automatically accessed by (OUTB @HL) instruction, but cannot be done by the instructions other than this one.

Table 1.7.1 Port Address Allocation and Input/Output Instructions

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INTEGRATED CIRCUIT

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TMP47C20P



(1) K₀ (K₀₃ \sim K₀₀) Port

This is a 4-bit port used for input.

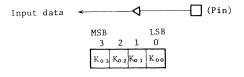


Fig. 1.7.1 Ko Port

(2) $P_1 (P_{13} \sim P_{10}), P_2 (P_{23} \sim P_{20})$ Port

These ports are 4-bit ports with a latch used for output. The latch data can be read by the instruction.

These two ports can independently access by specifying port addresses IPO1/OPO1, and IPO2/OPO2. In addition, they can output 8-bit data by the (OUTB @HL) instruction.

PLA data conversion

A hardware PLA is not contained in the system; however, the function equivalent to it can be performed by access to the PLA data conversion table provided in the RCM by use of the (CUTB @HL) instruction.

The PLA referring instruction (OUTB @HL): This instruction reads out the 8-bit data stored in the program memory, whose address is determined by the contents of the data memory indicated by the contents of the H and L registers as well as the contents of the carry flag, and outputs the data to 8-bit ports P2 and P1. At this time OP11 is automatically selected as the port address.

INTEGRATED CIRCUIT



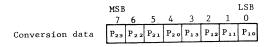
TMP47C20P

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Ports Pl and P2 are capable of reading the latch data by the instruction, so that the data output by the PLA referring instruction can be qualified or modified; that is, the convert pattern can be changed or the numbers of pattern will be increased.



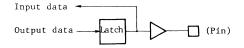


Fig. 1.7.2 P1 and P2 Ports

(3) $R_4(R_{43} \sim R_{40})$, $R_5(R_{53} \sim R_{50})$, $R_6(R_{63} \sim R_{60})$, $R_7(R_{73} \sim R_{70})$ Port

Each of these ports is a 4-bit I/O port with a latch. The latch should be set to "1" when the port is used as an input port. (But, these ports are only used to output ports with some input/output circuits.)

Pins R₇₃ - R₄₀ can be used for bit scanning for set/reset and test according to the contents of the L register by executing the (SET @L), (CLR @L) and (TEST @L) instructions. Table 1.7.2 shows the pins corresponding to the contents of the L register.

	Correspond- ing Pin	Lregister 3210	Correspand- ing Pin
0000	R40	1000	R60
0001	R41	1001	R61
0010	R42	1010	R62
0011	R43	1011	R63
0100	R ₅₀	1 1 0 0	R ₇₀
0 1 0 1	R51	1 1 0 1	R71
0 1 1 0	R52	1110	R72
0 1 1 1	R53	1111	R73

Table 1.7.2 Correspondence of Individual Bits of L Register and I/O Port



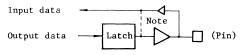
TECHNICAL DATA

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Note : For bit set/reset of port, latch output serves as input data.

Fig. 1.7.3 $R_4 \sim R_7$ Ports

(4) R₈ (R₈₃ ∿ R₈₀) Port

This is a 4-bit I/O port with a latch. The latch should be set to "1" when the port is used as an input port.

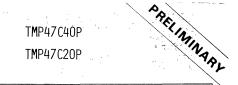
It is a port common to external interrupt input or external timer/ counter input. When it is driven by the external circuitry, such as external interrupt input or external timer/counter input, the latch must be set to "1". When it is used as normal I/O port, some measures, such as inhibition of the external interrupt input acceptance or disable of the mode depending on the external input of the timer/counter should be taken in a program.

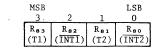
(Note) When pin R82 (\overline{INTI}) is used as a port, INT1 interrupt request takes place because the falling edge of the pin input/output is detected (interrupt enabling master F/F is normally set to "1"). This causes the CPU to process a dummy interrupt acceptance [e.g. the (RETI) instruction only is executed]. When pin R₈₀ ($\overline{INT2}$) is used, INT2 interrupt request also takes place in the same manner as the case of pin R₈₂, but the interrupt request is not accepted by merely resetting the LSB (EIR₀) of the enable interrupt register to "0" in advance. Therefore, the above processing is not required.

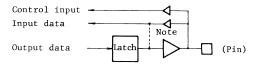




TECHNICAL DATA







Note: For bit set/reset of port, latch output serves as input data.

Fig. 1.7.4 Re Port

(5) R9(R92 ∿ R90) Port

This is a 3-bit I/O port with a latch, and the latch must be set to "1" when it is used as input port. The R9 port is also used as serial port. The latch must be set to "1" when R9 port is used as serial port. The port used as normal I/O port is not entirely influenced by disabling the serial port. Pin R93 is not mounted in the port, but "1" is read by accessing to pin R93 in a program.

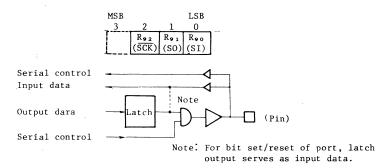


Fig. 1.7.5 R, Port





1.8 Interrupt control circuit (INTR)

Interrupt factors are composed of two from the external circuitry, and four from the internal circuitry. By setting the interrupt latch provided for each factor, an interrupt request is generated to the CPU. The interrupt latch is set when the edge of the input signal is detected.

The interrupt request is not always accepted by the CPU if generated. It is not accepted till the priority in the six factors determined according to the hardware and the enabling/disabling control by the program become all affirmative.

In order to control enabling/disabling of interrupt by the program, an F/F (EIF) and a 4-bit register (EIR) are provided. By using these means, preferential acceptance of the interrupt factors by the program, and multiple interrupt control can be realized.



TECHNICAL DATA

TMP47C40P TMP47C20P PREI MINARY

Factor			Priority according to hardware	Interrupt Latch	Enable con- dition accord- ing to program	Vector Address
Exte	ernal interrupt l	(INT1)	(Higher) 1	INTL5	(Note 1) EIF = 1	002
	Serial Input/Output interrupt	(1510)	2	INTL ₄	$EIF \cdot EIR_3 = 1$	004
interrupt	Timer counter l Overflow interrupt	(IOVF1)	3	INTL ₃	$EIF \cdot EIR_2 = 1$	006
Internal i	Timer counter 2 Overflow interrupt	(10VF2)	4	INTL ₂	(Note 2) EIF·EIR ₁ = 1	008
L	Timer interrupt of divider	(ITMR)	5	intl ₁	(Note 2) EIF·EIR ₁ = 1	00A
Exte	ernal interrupt 2	(INT2)	6 (Lower)	intl _o	$EIF \cdot EIR_0 = 1$	00C

Interrupt enabling master F/F

Interrupt enabling register (EIR)



MSB 3	2	1	LSB 0
EIR3	EIR ₂	EIR_1	EIRO

- (Note 1) Since EIR register cannot make disabling of the INT1 interrupt, this interrupt is always accepted under the interrupt enabled condition (EIF = 1). Therefore, this should be used for the interrupt requiring the first priority such as emregency interrupt.
- (Note 2) The given acceptance condition by the program is the same in IOVF2 and ITMR; accordingly, the action of these interrupts to the acceptance/inhibition control is the same.

Table 1.8.1 Interrupt Factors





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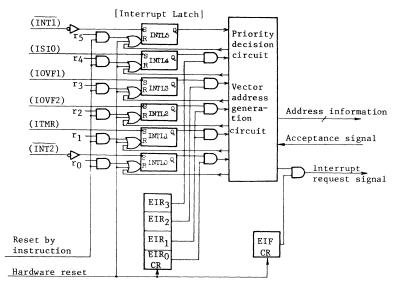
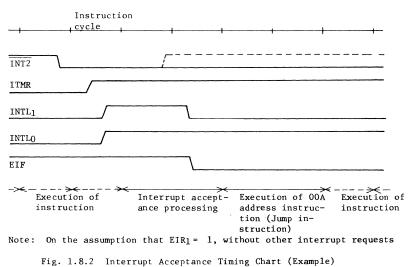


Fig. 1.8.1 Interrupt Control Circuit





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(1) Interrupt processing

The interrupt request signal to be sent to the CPU is held by the interrupt latch till the request is accpeted or the latch is reset by the initialization operation or instruction.

The processing for the interrupt acceptance is performed within two instruction cycle time after the completion of the execution of instruction (after the completion of the timer/counter processing if it is required).

The following operations are performed by the interrupt service program.

- The contents of the program counter and flag are saved in the stack.
- (2) The vector address is set to the program counter according to the interrupt factor.(A jump instruction to each interrupt service program is usually

stored in the program memory corresponding to the vector address.)

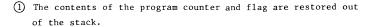
- (3) The status flag is set to "1".
- (4) The interrupt enabling master F/F is reset to "0" to inhibit the subsequent interrupt acceptance for a time.
- (5) The interrupt latch of the accepted interrupt factor is reset to "0".
- (6) The instruction stored in the vector address is executed.

The interrupt service program terminates after the execution of the (RETI) instruction.

The following operations are performed by the (RETI) instruction.



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(2) The interrupt enabling master F/F is set to "1".

When the multiple interrupt is accepted, the interrupt enabling master F/F should be set by the instruction. At this time, the enabling/disabling for each interrupt factor can be changed by updating the interrupt enabling register by the (XCH A, EIR) instruction.

The program counter and flag are automatically saved/restored in the interrupt processing. However, if saving/restoring of the accumulator and other registers is necessary, it should be designated by a program.

(2) Interrupt control by program

EIF

This is an enabling interrupt master F/F. Interrupt is put in the interrupt acceptance enabling state by setting the EIF to "1". It is reset to "0" immediately after having accepted an interrupt to inhibit the subsequent interrupt acceptance for a time, but is set to "1" again by the (RETI) instruction after the completion of the interrupt service program to return the enable state again. And then the other interrupt can be received.

The EIF can be set/reset in a program by using the (EICLR IL,r) and (DICLR IL, r) instructions. It is reset to "0" at initialization operation.

EIR register

This is a 4-bit register used for selection/control of enabling/disabling of the interrupt acceptance in a program.



TECHNICAL DATA

TMP47C40P TMP47C20P



Read/write operation is performed by use of the (XCH A, EIR) instruction. It is set to "O" at the initialization operation.

Interrupt latch

The interrupt latches $(INTL_5 - INTL_0)$ provided for each interrupt factor are set by the rising edge of the input signal if the interrupt is caused by the internal factors, and are set by the falling edge of the input pin if it is caused by the external factors. Then, interrupt request signal is sent to the CPU. The interrupt latch holds the signal till the interrupt request is accepted, and is reset to "0" immediately after the interrupt has been accepted.

Since the interrupt latch can be reset to "O" by the (EICLR IL, r), (DICLR IL, r) and (CLR IL, r) instructions, the interrupt request signal can be initialized by a program. The latch is reset to "O" at the initialization operation.

1.9 Frequency divider (FD)

The divider $({\rm FD}_1$ – ${\rm FD}_{18})$ is made up 18-stage binary counter, and its output is used to generate various internal timing.

The basic clock (fc Hz) is divided into sixteen by the timing generator and input to the divider; therefore, the output frequency at the last stage is $fc/2^{22}$ Hz.

It is reset to "O" at the initialization operation.

Timer Interrupt of divider (ITMR)

The divider is capable of sending the interrupt request for a certain frequency. Four different frequencies can be selected for timer interrupt by instructions.



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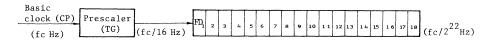
TECHNICAL DATA

TMP47C40P TMP47C20P



The command register is accessed as port address OP19, and is reset to "O" at time of the initialization.

The timer interrupt of divider is caused from the rising edge of the first output of the divider after the data has been written in the command resister.



(a) Structure of frequency divider

	MSB			LSB	
Port address	3	2	1	0	
(¹⁰¹¹ address) OP19					(*: don't care)
	*	0	*	*	: Disable
	*	1	0	0	: Interrupt frequency $fc/2^{10}Hz$
	*	1	0	1	: " fc/211H2
	*	1	1	0	: " fc/212Hz
	*	1	1	1	: " fc/213Hz

Interrupt fre-	For example,
quency (Hz)	fc=4.194304MHz
fc/210	4,096 Hz
fc/211	2,048 Hz
fc/212	1,024 Hz
fc/213	512 Hz

⁽b) Command register

Fig.	1.9.1	Frequency	Divider
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1.10 Timer/Counter (TC₁, TC₂)

Two channels of 12-bit binary counter is contained to count time or event.

Since the RAM address with 4-bit unit is allocated to the timer/counter, the initial value setting and the content reading of the timer/counter can be executed by the RAM manipulated instructions.

	LSB		
(Timer/Counter 1)			
(IImer/oouncer I)	TC1H	TC1M	TC1L
(RAM Address)	(F6)	(F5)	(F4)
	MSB		LSB
(Times (Geoster 2)	MSB	TC2	LSB
(Timer/Counter 2)	MSB TC2H	TC2 TC2M	LSB TC2L

Fig. 1.10.1 Timer/Counter

(1) Timer/Counter Control

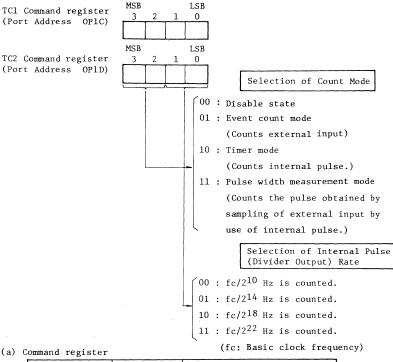
The timer/counter is controlled by the command specifying the operation mode. The command register for the timer/counter 1 and timer/counter 2 is accessed as port addresses OPIC and OPID, respectively. It is reset to "0" at the initialization operation. The count operation is started from the first rising edge of the count pulse applied by setting the value (mode) to the command register.

When the timer/counter is not used, the RAM addresses corresponding to the timer/counter can be used to store the user processing data by selecting the "disable" state. In the timer mode, the external input pins can be used as I/O ports $[R_{83}$ (T1), R_{81} (T2)].



TECHNICAL DATA





(;	a)	Command	register
----	----	---------	----------

Internal Pulse	Max. Setting	For example, fc=	
Rate (Hz)	Time (SEC)	Internal Pulse Rate (Hz)	Max. Setting Time (SEC)
fc/2 ¹⁰	2 ²² /fc	4,096	1
fc/2 ¹⁴	2 ²⁶ /fc	256	16
fc/2 ¹⁸	2 ³⁰ /fc	16_	256
fc/2 ²²	2 ³⁴ /fc	1	4,096

(b) Selection of timer rate

Fig. 1.10.2 Control of Timer/Counter



TECHNICAL DATA



TMP47C40P TMP47C20P



(2) Count Operation

When the rising edge of the count pulse is detected, the count latch is set to send a count request to the CPU.

The count operation of the timer/counter is performed requiring one instruction cycle time after completion of the instruction execution. The execution of the next instruction and the acceptance of the interrupt request are kept waiting during the operation. When the count request is sent from the timer/counter 1 and 2, at the same time, the count request of the timer/counter 1 is preferentially executed.

The maximum frequency applied to the external input pin under the event counter mode is fc/64 Hz if one channel is used. When two channels are used, fc/64 Hz is applied to the timer/counter 1, and fc/80 Hz to the timer/counter 2.

In the timer mode, the maximum frequency is determined by a command.

The maximum frequency applied to the external input pin in the pulse width measurement mode should be the frequency level available for analyzing the count value in the program. Normally, the frequency sufficiently slower than the designated internal pulse rate is applied to the external input pin.





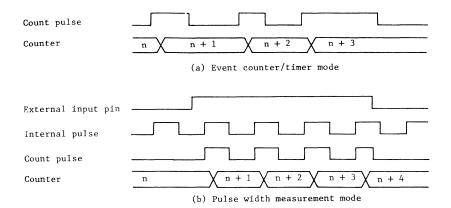


Fig. 1.10.3 Mode and Count Value of Timer/Counter

Decrease in execution speed of instruction due to count operation

The CPU carries out the count operation requiring one instruction cycle time for the count request. Therefore, this causes the decrease in the apparent speed of instruction execution. Some examples are shown below :

(a) In the timer mode with count pulse rate of fc/2 $^{10}~{\rm Hz}$:

The count operation is inserted once every 6^{2} -instruction cycle time, so that the apparent speed is decreased by 1/63=1.6% instruction execution speed. For example, the apparent speed is 4.063µs to 4µs instruction execution speed.

(b) In the event count mode :

It depends on the count pulse rate applied to the external input pin. In the worst case, when the timer/counter 1 and 2 are operated at the same time with the maximum count pulse rate, the count operation is inserted once every 4-instruction cycle time for the timer/counter 1, and once every 5-instruction cycle time for the timer/counter 2.



TECHNICAL DATA

TMP47C40P TMP47C20P PREIMINARY

The apparent speed of the instruction execution, therefore, decreases by 9/11 = .82%. The apparent speed is 7.28μ s to 4μ s instruction execution speed.

(3) Interrupt by overflow (IOVF1, IOVF2)

At the time when the overflow occurs, the timer/counter generates the interrupt request.

That is, the interrupt request is generated when the count value of FFF is changed to 000. The counting is continued after the interrupt request signal is generated. Assuming that the CPU provides the interrupt enabling state, and that the interrupt is accepted as soon as the overflow interrupt has been generated, the interrupt processing can be performed in the sequence illustrated in Fig. 1.10.4.

.	Instruction cycle			
Count pulse				
Count <u>request</u>				
Detection of ov	verflow	л		
Occurr <u>ence of I</u>	OVF			
Execu of in struc	- Count	Execution of in- struction	Interrupt acceptance processing	Execution of instruction (jump)
Fig.	1.10.4 Timing (Chart of Timer	/Counter in	

Interrupt by Overflow





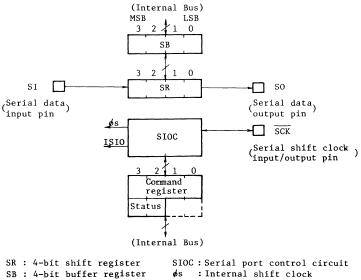
1.11 Serial Port (SIO)

A 4-bit serial port with a buffer is provided to transfer the serial data from/to the external circuitry. It is connected to the external circuitry through three pins [R92 (\overline{SCK}), R91 (S0), R90 (SI)]. Since these pins are also used as port R9, the output latch of the R9 port should be set to "1" when the serial port is used. When it is not used, the pins can be used as I/O port R9.

Pin R90 in the transmit mode and pin ${\rm R}_{91}$ in the receive mode are also available as ${\rm I}/0$ port pin.

(1) Circuit configuration

The serial port consists of a 4-bit shift register, a 4-bit buffer register, and its control circuit.



ISIO : Interrupt request

Fig. 1.11.1 Circuit Configuration of Serial Port





TECHNICAL DATA

(2) Serial port control

The serial port operation is controlled by the command. The command register is accessed with port address OPIF, and reset to "O" at the initialization operation. The operation status can be informed through the status input, which is accessed with port address IPOE.

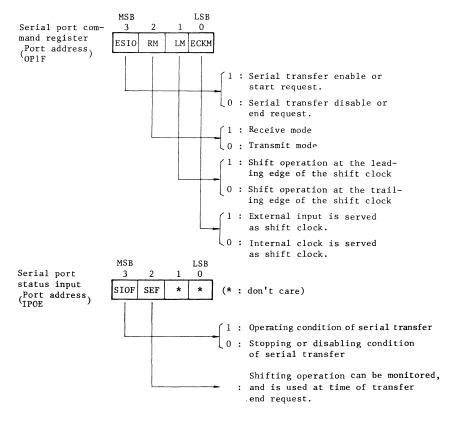


Fig. 1.11.2 Command Register, Status Input



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(3) Shift clock (SCK)

The following shift clock modes can be selected by the contents of the command register.

- (a) Clock source (External/internal mode)
- (b) Shift edge of clock (Leading edge/trailing edge mode)

Internal clock mode

 $fc/2^7$ Hz is used for the shift clock (when the basic clock frequency fc is 4.194304 MHz, the shift clock frequency is 32.768 kHz.). At this time, the clock is supplied to the external devices through the \overline{SCK} pin. If the data setting (transmit mode) or the data reading (receive mode) rate by the program cannot follow the clock rate, the shift clock is automatically stopped and the next shift operation is suspended until the data processing is completed ("Wait" operation).

External clock mode

The shift operation is performed by the clock provided from the external circuitry since the \overline{SCK} pin serves as an input.

Leading edge shift mode

Data is transmitted (transmit mode) or received (receive mode) at the leading edge of the \overline{SCK} pin signal.

Trailing edge shift mode

Data is received (receive mode) at the trailing edge of the $\overline{\text{SCK}}$ pin signal.

The \overline{SCK} pin must be set to the "high" level when the serial transfer is started. In the internal clock mode, the \overline{SCK} pin is automatically set to the "high" level because it serves as an output.



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(4) Operation mode

Selection of the following three transfer modes is available by changing the combination of the RM bit and LM bit of the command register.

RM (Bit 2)	LM (Bit 1)	ECKM (Bit 0)	Operation Mode
0	0	1/0	Can not be used
0	1	1/0	Transmit mode (Note) (External/Internal clock)
1	0	1/0	Receive(Trailing edge shift) mode (External/Internal clock)
1	1	1/0	Receive(Leading edge shift) mode (External/Internal clock)

(Note) Leading edge shift operation is performed.

Table 1.11.1 Operation Mode of Serial Port

In the transmit mode, the 4-bit data written to the buffer register from the CPU is shifted out by the shift register, and is output in the SO pin from the data of the LSB in sequence. The buffer register is accessed as the port address OPOF.

In the receive mode, the data to be input to the SI pin is shifted toward the LSB by the shift register in sequence, and is set in the buffer register after the 4-bit data has been received.

The CPU reads the contents of the buffer register, which is accessed as the port address IPOF.



TECHNICAL DATA

TMP47C40P TMP47C20P



Transmit mode

After this mode is set in the command register, the first transmit data (4-bit) is written in the buffer register (the data cannot be written in the buffer register, if the transmit mode is not set). Then the data can be transmitted by setting the ESIO (MSB of command register) to "1". The content of the buffer register is transferred to the shift register by the first shift clock, and the data in the LSB (D_0) is output to the S0 pin. The buffer register ter then becomes empty, so that the interrupt (ISIO) requesting the next data takes place (buffer empty). After that, the remaining data ($D_1 - D_3$) is automatically shifted out by the shift register by one data at a shift clock. The control by use of a program is not necessary in this operation.

Data is written in the buffer register by outputting the next transmit data (4-bit) to the port address OPOF in the interrupt service program, and at the same time the interrupt request is reset to "0".

Internal clock operation

In case of $fc/2^7$ Hz internal clock operation, if the next data is not set in the buffer register (OPOF has not been accessed by the program) though the 4-bit data has been entirely shifted out, the shift clock automatically stops, and the wait operation is taking place until the data is set.

The maximum transmission rate is 31250 bit/sec. at the 4 MHz basic clock.

417



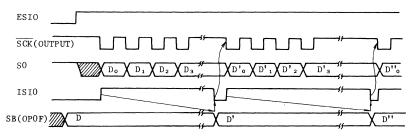
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TMP47C40P TMP47C20P



External clock operation

Since the shift operation synchronizes entirely with the clock provided from the external circuitry, the data should have been written in the buffer register before the next 4-bit data is shifted out. Therefore, the transfer rate is determined by the maximum time lag from the receipt of interrupt request (ISIO) to the writing of data in the buffer register by the interrupt service program.



(a) Internal clock operation (with wait operation)

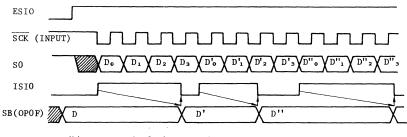




Fig. 1.11.3 Transmit Mode







TECHNICAL DATA

Completion of transmission

When the buffer register becomes empty, the interrupt occurs to request the next data. In case where the transmission is desired to be completed after the data is entirely transferred, the transmit operation can be stopped upon completion of transferring the current data shifted out, by resetting the ESIO to "0" without outputting the data. Whether or not the transfer operation is completed can be sensed in a program by the SIOF (MSB of the status input).

In the external clock operation, the ESIO must be reset to "0" before the next data is shifted out as in the data updating operation (however, the data is not updated when the operation is completed). When the wait operation have been already performed in the internal clock operation, the data transfer is terminated immediately after ESIO = 0.

One word transfer can be terminated by ESIO = 0 in the interrupt service program on receipt of the interrupt caused by the buffer empty.

419



TMP47C40P TMP47C20P



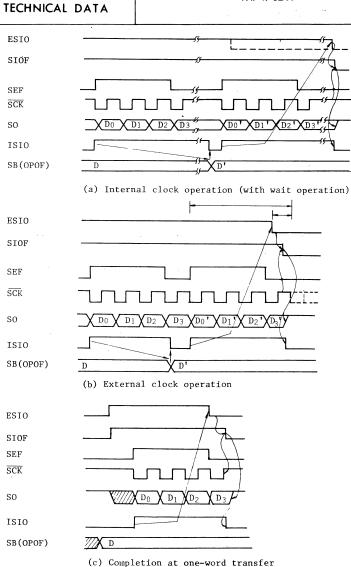


Fig. 1.11.4 Completion of Transmission



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TECHNICAL DATA

TMP47C40P TMP47C20P



Receive (trailing edge shift) mode

Data can be received by setting the receive mode in the command register as well as by setting the ESIO (MSB of command register) to "1". When the four data are received from the SI pin, the 4-bit data is transferred from the shift register to the buffer register. At the same time, interrupt (ISIO) takes place to request the data reading (buffer full). Since the shift register has been transferring the data to the buffer register, the shift operation is continued without waiting for the data being read.

When the data received from the port address IPOF is read in the interrupt service program, the interrupt request is reset. And then the next 4-bit data is transferred from the shift register to the buffer register if the buffer register has been full.

Internal clock operation

During the operation of the internal clock of $fc/2^7$ Hz, if the next 4bit data is not read out of the buffer register (the IPOF has not been accessed) in the program though the 4-bit data has been entirely input, the shift clock automatically stops, and the wait operation is taking place until the data is read out.

The maximum receiving rate is 31250 bit/sec at the 4 MHz basic clock.

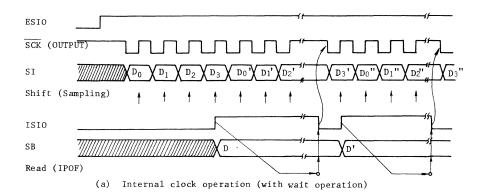
External clock operation

Since the shift operation synchronizes entirely with the clock provided from the external circuitry, the current data should have been read by the instruction before the next 4-bit data is transferred to the buffer register. The transfer rate is, therefore, determined by the maximum time lag from the receipt of interrupt request (ISIO) to the read of the data in the buffer register by the interrupt service program.

421



PREI MINARY



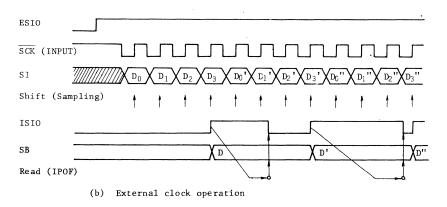


Fig. 1.11.5 Receive (trailing edge shift) Mode





Completion of receiving

When all of the data are read, the receiving of data can be completed upon termination of the current data transfer, by resetting the ESIO to "O".

Whether or not the data transmission is terminated can be sensed in a program by the SIOF (MSB of status input).

To complete the receive operation when the synchronization is desired between the serial transfer and interrupt service program (indicates data reading or completion of receiving), there are two ways according to the speed of shift clock.

The receive/transmit mode must be maintained without switching the mode until the last data is read out even if the completion of the data transfer is indicated; otherwise the contents of the buffer register will be lost.

(a) Sufficiently slow data transfer rate (external clock operation)

If the timing, operated by the external clock, is slow enough to reset the ESIO to "0" prior to the generation of the next shift clock, the ESIO can be reset to "O" in the interrupt service program which is loaded to read out the last data. Thereafter the last data is read.



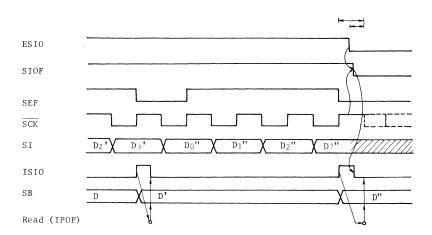


Fig. 1.11.6 Completion of Receiving (at slow transfer rate)

(b) Fast transfer rate

If the shift operation for the next data may start before the current data is read out by receipt of the interrupt request becuase the transfer rate is too fast, the interrupt service program which is loaded to read out the last data but one should be used to reset the ESIO to "0" after confirming that the SEF (bit 2 of status input) has been set to "1".

Thereafter, the data should be read. No operation is required to complete the data transfer in the interrupt service program for reading the last data.





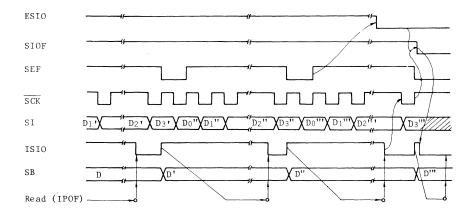
TMP47C40P TMP47C20P



The method mentioned above is usually taken for the internal clock operation. In the external clock operation, however, the reset of the ESIO and the read of data must be completed before the last data is transferred to the buffer register.



(a) Program sequence of receive end indication



(b) Timing Chart (in case of internal clock operation with wait operation)





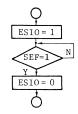
TECHNICAL DATA

TMP47C40P TMP47C20P

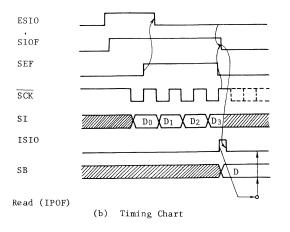


(c) One word transfer

The data receive operation starts after the ESIO is set to "1". Then, the ESIO is reset to "0" after confirming that the SEF status is set to "1". In this sequence, one interrupt casued by the buffer full takes place; therefore, the data should be read out by the service program.



(a) Program sequence of receiving start/end indication









TMP47C40P TMP47C20P



Receive (leading edge shift) mode

With this mode set in the command register, the data can be received by setting the ESIO (MSB of command register) to "1".

When the four data are received from the SI pin, the 4-bit data is transferred from the shift register to the buffer register. At the same time, the interrupt (ISIO) occurs to request the data reading (buffer full). Since the shift register is transferring the data to the buffer register, the shift operation has been continued without waiting for the data being read.

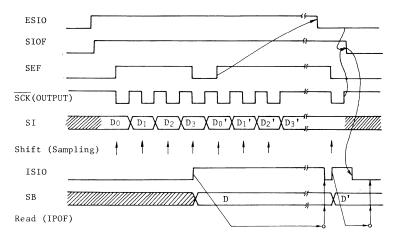
When the data received from the port address IPOF is read in the interrupt service program, the interrupt request is reset. And then the next 4-bit data is transferred from the shift register to the buffer register if the buffer register has been full.

The basic operation in the receive (leading edge shift) mode is equivalent to that in the receive (trailing edge shift) mode except that the edge for the shift clock is different, and that at time of the transfer start, the first shifted data has been already input from the external circuitry before the first shift clock is applied to the data receipt. Timing charts are shown below.

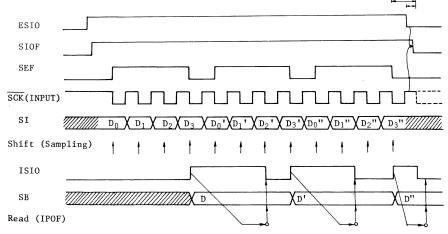




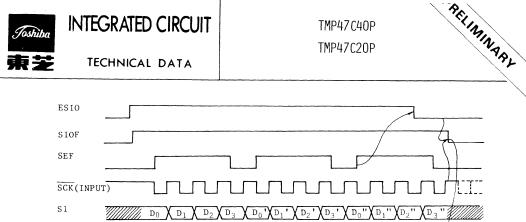


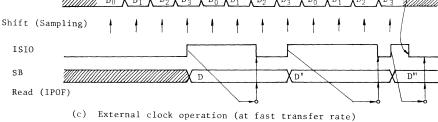


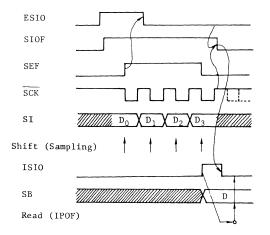
(a) Internal clock operation (with wait operation)



(b) External clock operation (at slow transfer rate)







(d) One-word transfer

Fig. 1.11.9 Receive (Leading Edge Shift) Mode





1.12 Hold control circuit (HOLDC)

The hold function is the function that holds the status (contents of the data memory, program counter and other registers) immediately before the system operation is stopped at lower power consumption making the most of the features of CMOS. The hold function is controlled by the HOLD terminal and the command register.

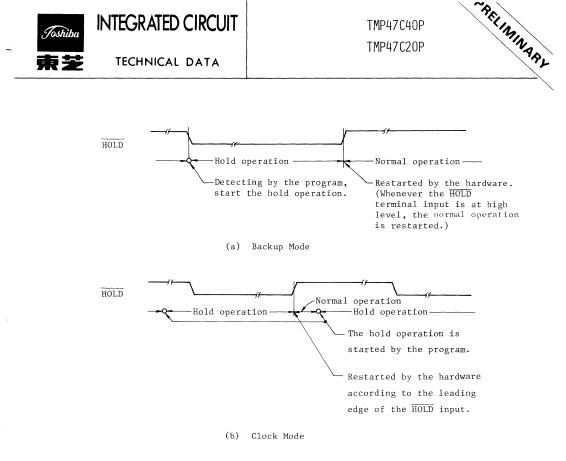
There are two operation modes for the hold operation as shown below. The designation for the hold operation start is made by the command in either mode.

(a) Backup mode

The $\overline{\text{HOLD}}$ terminal input controls the request/release of the hold operation. Namely, it is the state of the hold that the $\overline{\text{HOLD}}$ input is at the low level, and it is the state of the normal operations that the $\overline{\text{HOLD}}$ input is at the high level. This mode is used for backup of the capacitor when the main power supply is cut off, backup of the battery for a long time, etc.

(b) Clock mode

When the hold operation is started by the command even when the \overline{HOLD} terminal input is at the either levels, the hold operation is continued till the leading edge of the \overline{HOLD} terminal input is detected. This mode is used when signals in constant cycle are applied to the \overline{HOLD} terminal input in applications, for example, the clock or timer applications, where relatively short period program processings are repeatedly executed in constant cycle. For instance, the signal is applied to the \overline{HOLD} input from a source of oscillation at low power consumption.



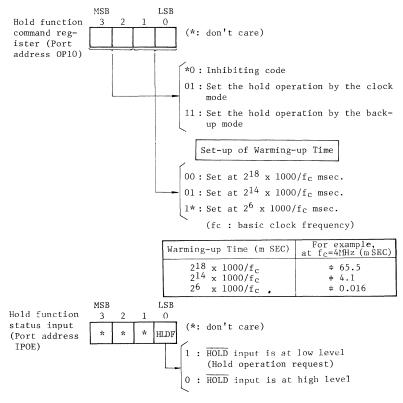






(1) Control of hold function

The hold operation is started by a command. The command register is accessed as the port address OP10, and operation mode selection, start control and set-up of warming-up time at time of restart are designated. Furthermore, it is possible to read the status of the HOLD terminal input from the status input. The status input is accessed as the port address IPOE.









(2) Hold operation

The hold operation holds the following state:

- The oscillation is stopped, and all internal operation are stopped. \bigcirc
- 2 The frequency divider is reset to "0".
- 3 The data memory, registers and port latches are held at the state immediately before the hold operation is started. It is therefore necessary to program in advance for the processing of uninterruptable program or status of the output terminal.
- 4 The program counter holds address of the instruction following the instruction directing start of the hold operation.

The hold operation is started under either mode when data is set in a command register. In the case of the backup mode, it is therefore necessary to recognize the status of the HOLD input (the hold operation request) on the program. To do this, the following two methods are considered available:

- (a) Test HLDF of the status input
- (b) Apply the HOLD input to the $\overline{INT_1}$ input as an interrupt request.

The hold operation is released when the HOLD terminal input becomes the high level. That is, under the backup mode, the hold status is kept held as long as the $\overline{\text{HOLD}}$ input is at the low level. However, if the $\overline{\text{HOLD}}$ input is already at the high level when a command directing start of the hold operation is executed, the hold operation is not started but the restarting sequence is started. Under the clock mode, the hold operation is continued till the leading edge of the HOLD input is detected.

INTEGRATED CIRCUIT



TMP47C40P TMP47C20P SREI ININARY

Further, in the hold operation, current consumption based on the oscillator and internal hardware is reduced, but current consumption based on the terminal interface (depending upon the external circuit and program) is not directly concerned with the hardware operation of the hold function, and it is therefore necessary to pay attention in designing system as well as interface circuits. When the input level is stable at the V_{DD}/V_{SS} level, current flows scarcely through the CMOS circuit. On the other hand, when the input level is floating from the V_{DD}/V_{SS} level (by about 0.3 \sim 0.5V), current will flow through the CMOS circuit. Therefore, in a case where the signal level at the I/O port (the open drain output with an input port circuit connected) becomes the 3-state status when the output transistor is cut off, current flows through the input port resistor and it is therefore necessary to fix the signal level by pulling up, etc.

Restart from Hold

The restart from hold is performed in the following sequence.

- Oscillation is started.
- ② The internal operation is kept stopped for a period of warming-up time assigned by the hold setting command to prevent the malfunction due to unstable oscillation.
- ③ After the warming-up time has passed ^(Note), the normal operation is restarted by the instruction following the instruction directing the hold setting. Further, the divider starts to operate from the state where it has been reset to "0".
- Note : Since the warming-up time is obtained from the value counted the basic clock by the divider, if oscillation frequency fluctuates at time of the restarting from the hold operation, the warming-up time shown in Fig. 1.12.2 may include errors. It is therefore necessary to regard the warming-up time as an approximate value.

The hold operation is released when the $\overline{\text{RESET}}$ terminal is set at the low level and the normal operation (the initialization operation) is immediately executed.

434





- 2. Basic operation and pin operation
 - 1. Instruction cycle
 - 2. Basic clock (CP) generation
 - 3. Initialization operation
 - 4. Hold Input
 - 5. Interrupt input
 - 6. Input/output port
 - 7. Other pins

The timing in each basic operation, and the configuration, function, and timing of the pins are described according to the above items.

The operation and timing with each component of the hardware are covered in detail in the description of each item of the components.

Different input/output port circuit system can be specified according to the port. The details to specify the type of input/output port circuit are given in the descreption covering the program tape format.

2.1 Instruction cycle

The instruction execution and the internal hardware control are synchronized with the basic clock (CP, fc Hz).

The minimum unit of the instruction execution is called the "instruction cycle", and all instructions are executed by one or two instruction cycles, each of which is called one-cycle instruction or two-cycle instruction.





TECHNICAL DATA

An instruction cycle consists of four machine cycles (M1 \sim M4), and each machine cycle requires four basic clock times.

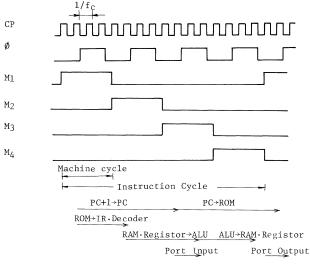


Fig. 2.1.1 Instruction Cycle

2.2 Basic clock (CP) generation

An oscillation circuit is contained, and the necessary clock is easily generated by connecting the resonator to external pins (XIN, $X_{\rm OUT}$). By the way, the oscillation circuit serves as Schmitt circuit.

The clock generated in the oscillation circuit is called the "basic clock" with which the internal control is synchronized. The basic clock is applied to the timing generator and the control circuit of system to provide various control signals.





The following are the examples of the resonator connection.



(a) For X-tal or ceramic resonator



(b) For RC



(c) For external oscillator

Fig. 2.2.1 Resonator Connections

2.3 Initialization operation

Initialization operation is performed by keeping the RESET pin to the low level. However, the following conditions are required to put the initialization operation into practice with certainty

- ① The supply voltage is within the operating voltage.
- The oscillation circuit operates stably.
- 3 The RESET is held at the low level in at least three instruction cycle time.



TMP47C40P TMP47C20P



TECHNICAL DATA

The following processing are performed by the initialization operation.

- Reset the program counter to "0"
- ② Set the status flag to "1".
- ③ Reset the interrupt enabling master F/F and the interrupt enabling register to "0", and also reset the interrupt latch to "0".
- ④ Reset the divider to "0".
- ⑤ Initialize the input/output port and command register to the fixed level.

The initialization operation is released due to the rise of the $\overrightarrow{\text{RESET}}$ pin to the high level, and the program can be executed from address 0 in sequence.

The RESET pin serves as Schmitt circuit input, and is connected with pull-up resistor ($\frac{1}{2}$ 200k Ω TYP., MOS-load resistor).

2.4 Hold input

The hold function is the function that holds the status immediately before the system operation is stopped at low power consumption. The $\overline{\text{HOLD}}$ terminal serves as Schmitt circuit input and is used to the signal input requesting or releasing of the hold operation. Further, for details of the hold operation, refer to the description of the hold control circuit.

Caution: To restart the system operation from the hold operation at low holding voltage, the following precaution is required. When supply voltage rises from holding voltage to operating voltage, the RESET input is also at the high level and rises together with supply voltage.





SREI ININARY

If a time constant circuit, etc. are externally added in this case, voltage build-up at the RESET input vill be slower than that of supply voltage. Therefore, if voltage level at the RESET input drops below the non-reversible high level (Schmitt circuit) at the RESET terminal input at this time, the initialization operation may possibly be executed.

2.5 Interrupt input

Two pins $(\overline{INT_1}, \overline{INT_2})$ are provided for the external interrupt input. Since these pins are common pins with R8 port, they can be used as I/O pins (R82, R80) respectively, if not used as the interrupt input pins.

The interrupt via INT_2 can be inhibited at any time by the program, but the interrupt via INT_1 is not inhibited by it independently. Therefore, when this pin is used for the R82 port, the interrupt will always take place due to the detection of the falling edge of the signal. It is necessary to set a dummy interrupt service program including the (RETI) instruction only, even if the INT_1 is not used.

The interrupt latch is set by the falling edge of the external inputs $(\overline{INT_1}, \overline{INT_2})$, and an interrupt request is made to the CPU. To assure that the interrupt latch is positively set or reset, and that the next interrupt request is set, both of the high and low levels should be kept for more than two instruction cycle time. The external interrupt input is the Schmitt circuit input.

439



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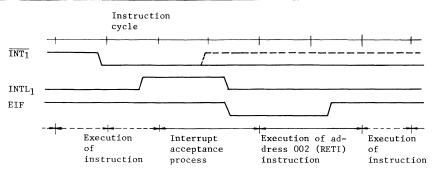


Fig. 2.5.1 Interrupt Timing (Dummy process of INT1 interrupt)

2.6 Input/output port

(1) Input/output timing

The timing to read the external data from the input port or I/0 port is in M3 machine cycle in the second cycle of the input instruction (two-cycle instruction). Since this timing cannot be externally recognized, the transient input data should be processed by a program.

The timing to output the data to the output port or I/O port is in M4 machine cycle in the second cycle of the output instruction (two-cycle instruction), but this timing cannot be externally recognized.

1st Cycle 2nd Cycle Input instruction M M M_2 M₃ M4 M_2 M₃ M4 Input strobe (a) Input Timing 1st Cycle 2nd Cycle Output instruction M₂ M₃ , M4 Mı M_2 M Mз М Latch strobe External pin (b) Output Timing

Fig. 2.6.1 Input/Output Timing

TMP47C40P, TMP47C41P



TMP47C20P, TMP47C21P

(2) Input/output circuit format

The input output circuit format of the input/output port is shown following. For the TMP47C40P, TMP47C20P, TMP47C41P and TMP47C21P, any of the input/ output circuit systems shown in the following tables can be selected. You can specify your input/output circuit system when requesting the program tape. (In the case of high breakdown voltage output type, production part's number is TMP47C41P or TMP47C21P.) *: Port **: Circuit

	Input/Output Circuit Code (IOCODE) FA				
**	Input (K _o)	Output (P_1, P_2)	I/O (R4,R5,R6)	I/O (R7)	I/O (R ₈ ,R ₉)
Input/Output Circuit Format	$R = 1k\Omega (TYP.)$		$R = 1k\Omega(TYP.)$	$R = 1k\Omega (TYP.)$	$R = 1k\Omega (TYP.)$
Remark	o No resistor is contained.	 o Sink open drain output. o Output latch is initial- ized to the high level. 	o Sink open drain output. o Output latch is initial- ized to the high level.	 o Sink open drain output. o Output latch is initial- ized to the high level. 	 o Schmitt cir- cuit input. o Sink open drain output. o Output latch is initial- ized to the high level.
	Input/Output Circ	cuit Code (IOC	ODE) HA		
**	Input (K ₀)	Output (P1,P2)	I/O (R4,R5,R6)	I/O (R7)	I/U (R8,R9)
Input/Output Circuit Format	$R = 1k\Omega (TYP.)$			$R = 1k\Omega (TYP.)$	$R = 1k\Omega (TYP.)$
Remark	o No resistor is contained.	 o Source open drain output. o High breakdown voltage output o Output latch is initial- ized to the low level 	 o Source open drain output. o High breakdown voltage output o Output latch is initialized to the low level. o Only for 	 Sink open drain output Output latch is initial- ized to the high level. 	 o Schmitt cir- cuit input. o Sink open drain output. o Output latch is initial- ized to the high level.

(Note: In this case, production part's number is TMP47C41P or TMP47C21P.)

441

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*: Port **: Circuit

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	Input/Output Circ	uit Code (IOCOD	,		
**	Input (K _o)	Output (P_1, P_2)	I/O (R4,R5,R6)	I/O (R7)	I/O (R ₈ ,R ₉)
Input/Output Circuit Format	$R_{IN} = 70k\Omega(TYP.)$		$R = 1k\Omega (TYP.)$	$R = 1k\Omega (TYP.)$	$R = 1k\Omega (TYP.)$
Remark	o Pull-up resistor is contained.	<pre>o Sink open drain output o Output latch is initial- ized to the high level.</pre>	<pre>o Sink open drain output o Output latch is initial- ized to the high level.</pre>	o Sink open drain output o Output latch is initial- ized to the high level.	<pre>o Schmitt cir- cuit input o Sink open drain output o Output latch is initial- ized to the high level.</pre>

*: Port **: Circuit

	Input/Output Circuit Code (IOCODE) FC				
**	Input (K _o)	Output (P1,P2)	(R4,R5,R6)	J/O (R7)	1/0 (R ₈ ,R ₉)
Input/Output Circuit Format	$\begin{array}{c} R \\ \hline R \\ R$		$R = 1k\Omega (TYP.)$	->	- λ (TYP.)
Remark	o Pull-down resistor is contained.	 Sink open drain output Output latch is initial- ized to the high level. 	<pre>o Sink open drain output o Output latch is initial- ized to the high level.</pre>	 Sink open drain output Output latch is initial- ized to the high level. 	 o Schmitt cir- cuit input o Sink open drain output o Output latch is initial- ized to the high level.



INTEGRATED CIRCUIT

TMP47C40P TMP47C20P



*: Port **: Circuit

	Input/Output Circuit Code (IOCODE) HB				
**	Input (K _o)	Output (P_1, P_2)	(R4, R5, R6)	I/O (R7)	$1/0 (R_8, R_9)$
Input/Output Circuit Format	$R \rightarrow V_{DD}$ $R \rightarrow R_{IN}$ $R \rightarrow R_{IN}$ $R \rightarrow R_{IN}$ $R \rightarrow R_{IN}$ $R = 1k\Omega (TYP.)$			$R = 1k\Omega (TYP.)$	$R = 1k\Omega (TYP.)$
Remark	o Pull-up resistor is contained.	 o Source open drain output. o High breakdown voltage output o Output latch is initial- ized to the low level. 		o Sink open drain output. o Output latch is initial- ized to the high level	 o Schmitt cir- cuit input. o Sink open drain output. o Output latch is initial- ized to the high level.

(Note: In this case, production part's number is TMP47C41P or TMP47C21P.)

^{*:} Port **: Circuit

	Input/Output Circuit Code (IOCODE) HC				
***	Input (K _o)	Output (P_1, P_2)	(R_4, R_5, K_6)	I/O (R7)	I/O (R ₈ ,R ₉)
Input/Output Circuit Format	$R_{IIN} = 70k \Omega(TYP.)$ $R = 1k \Omega (TYP.)$			$R = 1k\Omega (TYP.)$	$R = 1k\Omega (TYP.)$
Remark	o Pull-down resistor is contained.	 o Source open drain output. o High breakdown voltage output o Output latch is initial- ized to the low level. 		<pre>o Sink open drain output. o Output latch is initial- ized to the high level.</pre>	 o Schmitt cir- cuit input. o Sink open drain output. o Output latch is initial- ized to the high level.

(Note: In this case, production part's number is TMP47C41P or TMP47C21P.)





2.7 Other pins

Timer/Counter input

Two pins (T_1, T_2) are provided for the external timer/counter inputs. Since these pins are common pins with R_8 port, they can be also used as I/O pins (R_{83}, R_{81}) , respectively, if not used as the timer/counter inputs.

The count latch is set by the rising edge of the external input (T_1, T_2) , and a count request is made to the CPU. To assure that the count latch is positively set or reset, both of the high and low levels should be kept for more tham two instruction cycle times. The external timer/counter input is the Schmitt circuit input.

Serial port

This port is connected to the external circuitry via three pins (\overline{SCK}, SO, SI) , which are also used for the R9 port. These pins can be used as the pins of the R9 port (R92, R91, R90), if not used for the serial port.

To assure that the shift operation is positively performed in the external clock mode, both of the high and low levels should be kept for more than two instruction cycle times.

The \overline{SCK} input in the external clock mode and the SI input in the receive mode are Schmitt circuit inputs.

TEST pin

This pin is used for the shipment test. To operate the user system with this pin, the input should be surely set to the low level. By the way, TEST pin is connected with pull-down resistor ($\approx 70 k\Omega$ TYP.).

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3. Instructions

The TLCS-47 series microcomputer is provided with 90 instructions, which are software compatible within the series. The instructions of the TLCS-47 series is consist of 1-byte instructions or 2-byte instructions. To classify them in terms of the execution time, there are 1-cycle instructions and 2-cycle instructions.

l-byte, l-cycle instructions are mainly used in this series, and are arranged so as to improve the program efficiency.

	Total	90
2-byte	2-cycle instruction	39
1-byte	2-cycle instruction	11
l-byte	l-cycle instruction	40

(a) Classification by byte/cycle

Total	90
Other instruction	1
Branch, subroutine instruction	6
Input/Output instruction (Note 2)	6
Bit manipulation instruction	24
Logical instruction	9
Arithmetic instruction	16
Compare instruction	6
Move instruction (Note 1)	22

(Note 1) : Including ROM data referring instructions (Note 2) : Including PLA referring instruction.

(b) Classification by function Table 3.0.1 Classification of Instructions.

445





TECHNICAL DATA

3.1 Description of symbols

The following symbols are used for describing the instructions in the following explanations.

Symbol	Description
AC	Accumulator
M[x]	Data memory (Address x)
HR	H register
LR	L register
P[p]	Port (Address p)
FLAG	Flag
CF	Carry flag
ZF	Zero flag
SF	Status flag
GF	General flag
PC	Program counter
STACK[(SPW)]	Stack (Stack level is indicated by the contents of stack
	pointer word.)
SPW	Stack pointer word
EIF	Enable interrupt master F/F
EIR	Enable interrupt register
INTLj	Interrupt latch (j = 5 - 0)
DC	Data counter
ROM[x]	Program memory (Address x)
(ROM _H ,ROM _L)	(High-order 4 bits or low-order 4 bits are expressed by
	suffix H/L.)
÷	Transfer
÷	Exchange
+	Addition
-	Substraction
Λ	Logical AND of the corresponding bits
v	Logical OR of the corresponding bits
¥	Exclusive OR of the corresponding bits





TMP47C40P TMP47C20P



Symbol	Description					
(CF)	Inversion of carry flag contents					
null	Processed result is transferred nowhere					
(AC)	Contents of accumulator					
(H.L)	Contents of 8 bits coupling H register with L register					
M[(H.L)]	Contents of data memory for which the contents of 8 bits coupling H register with L register is used as address.					
(AC) 	Contents of bit assigned by b of accumulator.					
(LR)<3:2>	Contents of bit 3 to bit 2 of L register					
(PC)<11:6>	Contents of bit 11 to bit 6 of program counter					

3.2 Description of instructions (*): Note 1 (**): Exec.cycle (**): Hexadecimal

Item Class	Assembler Mnemonic	Object Code	(*)	Function Flag(*) (**	*)
		Binary	(***)	Functional Description	
	LD A, @HL	0000 1100	0 C	(AC)+M[(H·L)] – Z 1 1 Loads the contents of the data memory specified by the H and L registers in the ac- cumulator.	
Instruction	LD A, x	0011 1100 x7x6x5x4 x3x2x1x0	3 C x _H x _L	(AC)+M[x]- Z 12Loads the contents of the data memory specified by the x of the instruction field ithe accumulator.	-
	LD HL, x	0010 1000	28 x _H x _L	$\begin{array}{c c} (LR) \leftarrow M[x], (HR) \leftarrow M[x+1] \\ x' = x_{1}x_{6}x_{5}x_{4}x_{3}x_{2}00 \end{array} \qquad - 1 2$:
Move		X7X6X5X4 X3X2X1X0	nL	Loads the consecutive two-word contents of the data memory specified by the x' (modi- fied x) of the instruction field in the H and L registers.	-
	LD A, #k	0100 k ₃ k ₂ k ₁ k ₀	4 k	(AC)+k - Z 1 1 Loads the immediate data k of the instruc- tion field in the accumulator. Serves as the clear instruction when k = 0.	-



TECHNICAL DATA



ltems	Assembler Mnemonic	Object Code		Function Flag(*) CF[ZF]SF (**)
Class		Binary	(**)	Functional Description
	LD H, #k	1 1 0 0 k ₃ k ₂ k ₁ k ₀	Ck	$\begin{array}{ c c c c c c c c } (HR) \leftarrow k & - & - & 1 & 1 \\ \hline Loads the immediate data k of the instructure tion field in the H register. Serves as the clear instruction when k = 0. \end{array}$
	LD L, #k	1 1 1 0 k3k2k1k0	Ek	$\begin{array}{c c c c c c c c c c c c c c c c c c c $
	LDL A, @DC	0011 0011	33	(AC)+ROML[(DC)]- Z 12Loads the lower-order 4 bits of the data readout of the data table of the program memoryspecified by the data counter, in the ac-cumulator.
cuction	LDH A,@DC+	0011 0010	32	$\begin{array}{ c c c c c } \hline (AC) + ROM_H[(DC)], (DC) + (DC) + 1 & - Z & 1 & 2 \\ \hline Loads the higher-order 4 bits of the data read out of the data table of the program memory specified by the data counter, in the accumulator, and then increments the contents of the data counter. [Note 2] \\ \hline \end{array}$
Move Instruction	ST A, @HL	0 0 0 0 1 1 1 1	OF	$\begin{array}{c c c c c c c c c c c c c c c c c c c $
Mor	ST A,@HL+	0001 1010	1 A	$\begin{array}{c c} M[(H \cdot L)]_{+}(AC), (LR)_{+}(LR)+1 & - Z \ \overline{C} & 1 \\ \hline \\ Stores the contents of the accumulator in the data memory specified by the H and L registers, and then increments the contents of the L register. [Note 3] \\ \end{array}$
	ST A,@HL-	0001 1011	1 B	$\begin{array}{ c c c c c c c c c c c c c c c c c c c$
	ST A, x	0011 1111 x ₇ x ₆ x ₅ x ₄ x ₃ x ₂ x ₁ x ₀	3 F x _H x _L	$\begin{array}{c c} M[x]^+(AC) & - & - & 1 & 2 \\ \hline Stores the contents of the accumulator in the data memory specified by the x of the instruction field. \end{array}$
	ST ∦k,@HL+	1111 k ₃ k ₂ k ₁ ko	Fk	$ \begin{array}{c c c c c c c c c c c c c c c c c c c $



TECHNICAL DATA

TMP47C40P TMP47C20P



Items Class	Assembler Mnemonic	Object Code	Function Flag(*) CF[ZF]SF (**)
Class		Binary (**	
	ST ∦k, y	0 0 1 0 1 1 0 1 2 1 k ₃ k ₂ k ₁ k ₀ y ₃ y ₂ y ₁ y ₀ k y	
	MOV H, A	0001000010	(AC)+(HR) Loads the contents of the H register in the accumulator.
	MOV L, A	0 0 0 1 0 0 0 1 1 1	(AC)+(LR) - Z 1 1 Loads the contents of the L register in the accumulator.
uction	ХСН А, Н	0011000036	(HR)\$\$(AC)- Z 1 2Exchanges the contents of the accumulator for those of the H register.[Note 2]
Move Instruction	XCH A, L	0011000131	(LR) $\stackrel{+}{\rightarrow}$ (AC)- Z 1 2Exchanges the contents of the accumulator for those of the L register.[Note 2]
Mo	XCH A,EIR	0001001113	(EIR) \$\$(AC) 11Exchanges the contents of the accumulator for those of the interrupt enable register.
	XCH A,@HL	0000110101	M[(H·L)] (AC)- Z 11Exchanges the contents of the accumulator for those of the data memory specified by the H and L registers.[Note 2]
	XCH A, x	0011110131 x ₇ x ₆ x ₅ x ₄ x ₃ x ₂ x ₁ x ₀ x _H x	
	XCH HL, x	00101001 x ₇ x ₆ x ₅ x ₄ x ₃ x ₂ x ₁ x ₀ x _H x	$X' = X_7 X_6 X_5 X_4 X_3 X_2 (0)$





TECHNICAL	DATA
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ltems Class	Assembler Mnemonic	Object Code Binary	(* *)	Function Functional Description
	CMPR A,@HL	00010110	1 6	null+M[(H·L)]-(AC) \overline{B} Z Z1Compares the contents of the data memory spec- ified by the H and L registers with those of the accumulator.
	CMPR A, x	0 0 1 1 1 1 1 0 x ₇ x ₆ x ₅ x ₄ x ₃ x ₂ x ₁ x ₀	3 E x _H x _L	$\begin{array}{c c} \mbox{nill+M[x]-(AC)} & \mbox{\overline{B} z \overline{z}} & \mbox{2} \\ \mbox{Compares the contents of the data memory spec-} \\ \mbox{ified by the x of the instruction field with} \\ \mbox{those of the accumulator.} \end{array}$
Compare Instruction	CMPR A,#k	1101 k ₃ k ₂ k ₁ k ₀	Dk	$\begin{array}{c c} \mbox{null+k-(AC)} & \mbox{B z } \overline{Z} & \mbox{l} \\ \hline \mbox{Compares the immediate data k of the in-} \\ \mbox{struction field with the contents of the ac-} \\ \mbox{cumulator. Serves as the accumulator test} \\ \mbox{instruction when } k = 0. \\ \end{array}$
Compare In	CMPR H,#k	0 0 1 1 1 0 0 0 1 1 0 1 k ₃ k ₂ k ₁ k ₀	38 Dk	null+k-(HR)- Z B2Compares the immediate data k of the in- struction field with the contents of the H register. Serves as the H register test in- struction when k = 0.2
	CMPR L,∦k	0 0 1 1 1 0 0 0 1 0 0 1 k ₃ k ₂ k ₁ k ₀	38 9k	null+k-(LR)- Z B2Compares the immediate data k of the in- struction field with the contents of the L register. Serves as the L register test in- struction when k = 0.
	CMPR y,∦k	0 0 1 0 1 1 1 0 k ₃ k ₂ k ₁ k ₀ y ₃ y ₂ y ₁ y ₀	2 E k y	null+k-M[y]BZZ2Compares the immediate data k of the in- struction field with the contents of the data memory specified by the y (page 0) of the in- struction field. Serves as the data memory test instruction when k = 0.
Arithmetic Instruction	INC A	0000 1000	08	$(AC) \leftarrow (AC)+1$ - Z \overline{C} 1 Increments the contents of the accumulator.
Arith Instru	INC L	0 0 0 1 1 0 0 0	18	$\begin{array}{ c c c c c } (LR) \leftarrow (LR) + 1 & - Z \ \overline{C} & 1 \\ \hline Increments the contents of the L register. \end{array}$



TECHNICAL DATA

TMP47C40P TMP47C20P



Items	Assembler	Object Code		Function $\frac{Flag(*)}{CF 2F SF}(**)$
Class	Mnemonic	Binary	(***)	Functional Description
	INC @HL	0000 1010	0 A	$ \begin{array}{c c} M[(H \cdot L)] + M[(H \cdot L)] + 1 & -z \overline{c} & 1 \\ \hline \\ Increments the contents of the data memory \\ specified by the H and L registers. \end{array} $
	DEC A	0000 1001	09	$(AC) \leftarrow (AC) - 1$ $- Z \overline{B}$ 1 Decrements the contents of the accumulator.
	DEC L	0 0 0 1 1 0 0 1	19	(LR)+(LR)-1 - Z B 1 Decrements the contents of the L register.
ion	DEC @HL	0000 1011	ОВ	$\begin{array}{ c c c c c c c c c c c c c c c c c c c$
Arithmetic Instruction	ADDC A,@HL	00010101	15	$\begin{array}{ c c c c c c c c c c c c c c c c c c c$
Arith	ADD A,@HL	00010111	17	$(AC) + (AC) + M[(H \cdot L)]$ – Z C 1 Adds the contents of the data memory spec- ified by the H and L registers to those of the accumulator, and places the result in the accumulator.
	ADD A, #k	0 0 1 1 1 0 0 0 0 0 0 0 k ₃ k ₂ k ₁ k ₀	38 0k	$\begin{array}{c c c c c c c c c c c c c c c c c c c $
	ADD H, #k	0 0 1 1 1 0 0 0 1 1 0 0 k ₃ k ₂ k ₁ k ₀	38 Ck	(HR)+(HR)+k- Z C2Adds the immediate data k of the instructionfield to the contents of the H register, andplaces the result in the H register. Servesas the H register increment instruction orthe decrement instruction when k = 1 or F,respectively.



TECHNICAL DATA



Items	Assembler Mnemonic	Object Code		Function Flag(*) (*	*)
Class	Inchonic	Binary	(**)	Functional Description	
	ADD L,#k	0011 1000 1000 k₃k₂kık₀	38 8k	$(LR)+(LR)+k$ – Z \overline{C} 2 Adds the immediate data k of the instruction field to the contents of the L register, and places the result in the L register.	
u	ADD @HL,#k	0011 1000 0100 k ₃ k ₂ k ₁ k ₀	38 4 k	$M[(H \cdot L)] + M[(H \cdot L)] + k$ - Z C 2 Adds the immediate data k of the instruction field to the contents of the data memory specified by the H and L register, and places the result in the data memory. Serve as the correction instruction for the decimal addition and subtraction when k = 6 or A.	es.
Arithmetic Instruction	ADD y,#k	0 0 1 0 1 1 1 1 k ₃ k ₂ k ₁ k ₀ y ₃ y ₂ y ₁ y ₀	2 F k y	$\begin{array}{ c c c c c } \hline M[y]+M[y]+k & - z \ \overline{c} & 2 \\ \hline Adds the immediate data k of the instruction field to contents of the data memory specified by the y (page 0) of the instruction field, and places the result in the data memory. Serves as the correction instruction for decimal addition and subtraction when k = 6 or A. \\ \hline \end{array}$	n d
Ari	SUBRCA, @HL	00010100	14	$\begin{array}{c c} (AC)+M[(H\cdot L)]-(AC)-(\overline{CF}) & \overline{B} & Z & \overline{B} & 1 \\ \hline \\ Subtracts the contents of the accumulator a the inverse contents of the carry flag from the contents of the data memory specified b the H and L registers, and places the resul in the accumulator. \end{array}$	ind n y
	SUBR A,#k	00111000 0001 k ₃ k ₂ k ₁ k ₀	38 1k	$\begin{array}{c c} (AC)+k-(AC) & - Z \ \overline{B} & 2 \\ \hline \\ Subtracts the contents of the accumulator \\ from the immediate data k of the instruction \\ field, and places the result in the accumulator. Serves as the accumulator 2's complement instruction or the data inversion (1's complement) instruction when k = 0 or F, respectively. \\ \end{array}$	n



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TECHNICAL DATA

TMP47C40P TMP47C20P



Items	Assembler Mnemonic	Object Code		Function Flag(*) CF[ZF]SF (**)
Class	Memorie	Binary	(**)	Functional Description
Arithmetic Instruction	SUBR @HL, #k	00111000 0101 k ₃ k ₂ k ₁ k ₀	38 5k	M[(H·L)]+k-M[(H·L)]- Z B2Subtracts the contents of the data memory specified by the H and L registers from the immediate data k of the instruction field, and places the result in the data memory.2Serves as the data memory 2's complement in- struction or the data inversion (1's comple- ment) instruction when k = 0 or F, respective- ly.
	ROLC A	0000 0101	05	CFAC(rotate left) by 1 bitC Z C1Rotates the contents of the accumulator and carry flag to the left by one bit. [Note 4]
	RORC A	0000 0111	07	(rotate right) C Z C 1 (by 1 bit C Z C 1 Rotates the contents of the accumulator and carry flag to the right by one bit. [Note 4]
Logical Instruction	AND A,@HL	0001 1110	ŀΕ	$\begin{array}{ c c c c c } \hline (AC) \land M[(H \cdot L)] & - z \ \overline{z} & 1 \\ \hline Carries out the logical AND of the corresponding bits with the contents of the accumulator and those of the data memory specified by the H and L register, and places the result in the accumulator. \\ \hline \end{array}$
Logical [AND A,∦k	0011 1000 0011 k ₃ k ₂ k ₁ k ₀	38 3k	$(AC) \leftarrow (AC) \land k$ $-z \overline{z}$ 2 Carries out the logical AND of the corresponding bits with the contents of the accumulator and the immediate data k of the instruction field, and places the result in the accumulator.
	AND @HL,#k	0011 1000 0111 k ₃ k ₂ k ₁ k ₀	38 7k	$\begin{array}{c c c c c c c c c c c c c c c c c c c $



TMP47C40P TMP47C20P



TECHNICAL DATA

Items	Assembler	Object Code		Function
Class	Mnemonic	Binary	(**)	Functional Description
	OR A, @HL	0001 1101	1 D	$(AC)+(AC)\vee M[(H\cdot L)]$ – Z Z 1 Carries out the logical OR of the correspond- ing bits with the contents of the accumulato and those of the data memory specified by the H and L registers, and places the result in the accumulator.
Instruction	OR A, #k	0011 1000 0010 k ₃ k ₂ k ₁ k ₀	38 2k	$\begin{array}{ c c c c c } \hline (AC)+(AC)vk & -& Z & \overline{Z} & 2\\ \hline Carries out the logical OR of the correspond-ing bits with the contents of the accumulatorand the immediate data k of the istructionfield, and places the result in the accumulator$
Logical Inst	OR @HL,#k	0011 1000 0110 k ₃ k ₂ k ₁ k ₀	38 6k	$\begin{array}{ c c c c c c } M[(H.L)] \lor M[(H.L)] \lor k & - z \ \overline{z} \ 2 \\ \hline Carries out the logical OR of the correspond-ing bits with the contents of the data memoryspecified by the H and L registers and theimmediate data k of the instruction field,and places the result in the data memory. \end{array}$
	XOR A, @HL	00011111	1 F	$(AC) \leftarrow (AC) \forall M[(H \cdot L)] - Z \overline{Z} 1$ Carries out the logical exclusive OR of the corresponding bits with the contents of the accumulator and those of data memory specifi- ed by the H and L registers. and places the result in the accumulator.
ę	TEST CF	00000110	06	$(SF) \leftarrow (\overline{CF})$, $(CF) \leftarrow 0$ $0 - * 1$ Places the inverse contents of the carry flag in the status flag, and then resets the carry flag to "0".
Manipulation struction	TEST A, b	0101 11b ₁ b ₀	5 C+b	(SF) + (AC) < b > * 1 Places the inverse contents of the bit, which is specified by the b of the instruction field, of the accumulator, in the status flag
	TEST @HL,b	0 1 0 1 1 0 b ₁ b ₀	5 8+ъ	$(SF) + M[(H \cdot L)] < b >$ * 1 Places the inverse contents of the bit, which is specified by the b of the instruction field, of the data memory specified by the H and L registers, in the status flag.



TECHNICAL DATA



Items	Assembler	Object Code	Function Flag(*) (**)
Class	Mnemonic	Binary (**)	Functional Description
	TEST y, b	0 0 1 1 1 0 0 1 3 9 1 0 b₁b₀ y₃y₂y₁y₀ 8+b y	$(SF) \neq \overline{M[y]} < b >$ * 2 Places the inverse contents of the bit, which is specified by the b of the instruction field, of the data memory specified by the y (page 0) of the instruction field, in the status flag.
ио	TEST %P,b	001110113B 10b1b0p3p2p1p08+bp	$\frac{(SF)+\overline{P[p]} < b>}{Places the inverse contents of the bit, which is specified by the b of the instruction field, of the port (port register in the output port, and pin input in the input and I/O port) specified by the p of the instruction field, in the status flag.$
ion Instruction	TEST @L	0011011137	$(SF) \neq \overline{P[(LR) < 3:2 > + 4] < (LR) < 1:0 >>} * 2$ Places the inverse contents of the bit, which is specified by the lower-order two bits of the L register, of the ports R4 - R7 (pin input) specified by the higher two bits of the L register, in the status flag.
Manipulation	TESTP CF	0000010004	(SF)+(CF), (CF)+1 1 - * 1 Places the contents of the carry flag in the status flag, and then sets the carry flag to "1".
Bit	TESTP ZF	0000 1110 0E	$(SF) \leftarrow (ZF)$ * 1 Places the contents of the zero flag in the status flag.
	TESTP GF	0 0 0 0 0 0 0 0 1 0 1	(SF)+(GF) * 1 Places the contents of the general flag in the status flag.
	TESTP y,b	0 0 1 1 1 0 0 1 3 9 1 1 b ₁ b ₀ y ₃ y ₂ y ₁ y ₀ C+b y	(SF)+M[y] * 2 Places the contents of the bit, which is specified by the b of the instruction field, of the data memory specified by the y (page 0) of the instruction field, in the status flag.



TECHNICAL DATA

TMP47C40P TMP47C20P



Items	Assembler	Object Code		Function Flag(*) (**)
Class	Mnemonic	Binary	(**)	Functional Description
	TESTP %P,b	0 0 1 1 1 0 1 1 1 1 b,bo p,p2p1Po	3 В С+b Р	(SF)+P[p] * 2 Places the contents of the bit, which is spec- ified by the b of the instruction field, of the port (port register for the output port, and pin input for the input or I/O ports), which is specified by the p of the instruc- tion field, in the status flag.
	SET GF	0000 0011	03	(GF)+1 1 1 Sets the general flag to "1".
Bit Manipulation Instruction	SET @HL, b	0101 00bibo	5 b	$ \begin{array}{ c c c c c c } M[(H \cdot L)] < b \succ 1 & - & - & 1 & 1 \\ \hline \\ \text{Sets the bit, which is specified by the b of} \\ \text{the instruction field, of the data memory} \\ \text{specified by the H and L registers, to "1"}. \end{array} $
	SET y, b	0 0 1 1 1 0 0 1 0 0 b ₁ b ₀ y ₃ y ₂ y ₁ y ₀	39 by	$\begin{array}{c cccc} M[y] < b > +1 & - & - & 1 & 2 \\ \hline \\ Sets the bit, which is specified by the b of the instruction field, of the data memory specified by the y (page 0) of the instruction field, to "1". \end{array}$
t Manipula	SET %p, b	0011 1011 00b1b0 p3p2p1p0	3В by	$\begin{array}{c c c c c c c } P[p] < b > +1 & - & - & 1 & 2 \\ \hline \\ Sets the bit, which is specified by the b of the instruction field, of the port specified by the p of the instruction field, to "1". \end{array}$
Bít	SET @L	00110100	34	$\begin{array}{c c c c c c c c c c c c c c c c c c c $
	CLR GF	0000 0010	02	(GF)+0 - − 1 1 Clears the general flag to "0".
	CLR @HL, b	0101 01b ₁ b ₀	5 4+b	$ \begin{array}{c c c c c c c c c c c c c c c c c c c $



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TECHNICAL DATA



Items	Assembler	Object Code		Function $\frac{Flag(*)}{CF[2F]SF}$ (**)
Class	Mnemonic	Binary	(*) (* *)	Functional Description
	CLR y, b	0 0 1 1 1 0 0 1 0 1 b ₁ b ₀ y ₃ y ₂ y ₁ y ₀	3 9 4+b y	$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$
ction		0 0 1 1 1 0 1 1 0 1 b,b, p,p,p,p,	3 В 4+b р	$\begin{array}{c c c c c c c c c c c c c c c c c c c $
Manipulation Instruction	CLR @L	00110101	3 5	$\begin{array}{c c c c c c c c c c c c c c c c c c c $
	CLR IL, r	0 0 1 1 0 1 1 0 1 1 r ₅ r ₄ r ₃ r ₂ r ₁ r ₀	36 C+r _H r _L	$(INTL) < 5:0 > (INTL) < 5:0 > \Lambda r < 5:0 > 1 2$ Resets the interrupt latch INTLj when the rj of the instruction field is "0". (j = 5 - 0)
Bit	EICLR IL,r	0 0 1 1 0 1 1 0 0 1 r ₅ r ₄ r ₃ r ₂ r ₁ r ₀	3 6 4+r _H r _L	$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$
	DICLR IL,r	0 0 1 1 0 1 1 0 1 0 r ₅ r ₄ r ₃ r ₂ r ₁ r ₀	3 6 8+r _H r _L	$\begin{array}{ c c c c c c c c c c c c c c c c c c c$
Input In- struction	IN %P, A	0011 1010 0010 p3p2p1po	3 A 2 P	$(AC) \leftarrow P[p]$ – Z Z 2 Places the input data from the port specified by the p of the instruction field in the ac- cumulator.



TECHNICAL DATA



Items Class	Assembler Mnemonic	Object Code Binary (,	* **)	Function Flag(*) CF ZF SF (**) Functional Description
	IN %P, @HL	0 0 1 1 1 0 1 0 3 0 1 1 0 _{P3P2P1Po} 6	A P	$\begin{array}{c c c c c c c c c c c c c c c c c c c $
	OUT A, %P		А 2 р 4р	$\begin{array}{c c c c c c c c c c c c c c c c c c c $
Instruction	OUT @HL,%P	001110103 11 7 40 p ₃ p ₂ p ₁ p ₀ C+2		$\begin{array}{llllllllllllllllllllllllllllllllllll$
Input/Output Instruction	OUT #k,%P	0 0 1 0 1 1 0 0 2 k ₃ k ₂ k ₁ k ₀ p ₃ p ₂ p ₁ p ₀ k	C P	$\begin{array}{c c c c c c c c c c c c c c c c c c c $
	OUTB @HL	0 0 0 1 0 0 1 0 1	2	$P[2] \cdot P[1] \leftarrow ROM[F \cdot (E+(CF)) \cdot M[(H-L)]] 1 2$ Outputs the data (eight bits) of the program memory located in addresses FEO - FFF, which use a five-bit data connecting the contents of the data memory specified by the H and L registers and those of the carry flag, as lower-order five-bit addresses, to the P ₂ - P ₁ ports.
Branch [.] Subroutine Instruction	BS a	0 1 1 0 a ₁₁ a ₁₀ a ₉ a ₆ 6 a ₇ a ₆ a ₅ a ₄ a ₃ a ₂ a ₁ a ₀ a _M	- F	If SF=1 then $(PC) + a$ else null 1 2 Places the immediate data a of the instruc- tion field in the program counter if the status flag is at "1". If the status flag is at "0", sets the status flag only to "1", and moves to the next address.



TECHNICAL DATA

TMP47C40P TMP47C20P



Items	Assembler	Object Code		Function	Flag(*) CFZFSF	(**)
Class	Mnemonic	Binary	(**)	Functional Description		
ruction	BSS a	1 0 d5d4 d3d2d1d0	8+d _H d _L	If SF=1 then (PC)+a else null, a=(PC)<11.6 > .d Carries out the branch within a byte) if the status flag is at the immediate value d of the in field into the lower-order six program counter. Since the upd remains in the higher-order six this instruction is specified i address in the page, branching out to the next page. If the s at "0", it sets the status flag and moves to the next address.	"l"; brin struction bits of t ated valu bits, if n the las is carrie tatus fla only to	ngs n the st ed ng is "1",
Branch-Subroutine Instruction	CALL a	0 0 1 0 0 a ₁₀ a9a8 a7a6a5a4 a3a2a1ao	avar	STACK [(SPW)]+(PC), (SPW)+(SPW)-1 (PC)+a, $0 \le a \le 2,047$ Carries out the subroutine call contents of the program counter and decrements the stack pointe then places the immediate data struction field in the program However, the call address of th must be in the addresses 000 -7	; saves t in the s r word, a a of the counter. e subrout	stáck, and ín- ine
	CALLS a	0 1 1 1 n ₃ n ₂ n ₁ n ₀	7 n	STACK[(SPW)]+(PC),(SPW)+(SPW)-1 (PC)+a, a=8n+6(n+0), 134(n=0) Carries out the short form subr The operation is the same as th "CALL" instruction except that be set in the program counter i ally defined by the n of the in field.	at of the the value s automat	e to tic-
	RET	0010 1011	2 A	(SPW)+(SPW)+1,(PC)+STACK[(SPW)] Returns from the subroutine to program; increments the stack p and restores the data of the re from the stack to the program c	ointer wo turn addi	ord,



TMP47C40P TMP47C20P



TECHNICAL DATA

Item	Assembler	Object Code		Function $\frac{Flag(*)}{CF \not ZF \mid SF}$ (**)						
Class	Mnemonic	Binaty	(<mark>*</mark> *)	Functional Description						
tine on	RETI	0010 1011	2 В	(SPW)+(SPW)+1, (FLAG·PC)←STACK[(SPW)], (EIF)+1 * * * 2						
Branch•Subrout Instructio				Returns from the interrupt processing routine increments the stack pointer word, and re- stores the data of the return address from the stack and the data of the flag, to the program counter and the flag, respectively. And then, it sets the interrupt enable master F/F to "1".						
her ruc- on	NÖP	0 0 0 0 0 0 0 0	0 0	no operation 1						
Oth Instr tic				Moves to the next instruction without perform- ing any operation.						

Note 1. Setting Condition of Flag.

"C" indicates the carry output from the most significant position in the addition operation, and "B" indicates the borrow output from the most significant position in the subtraction operation.

"Z" indicates the zero detection signal to which "l" is applied only when either the ALU output of the processing result or all four bits of the data transferred to the accumulator are zero.

The flag is set to "C", " \overline{C} ", " \overline{B} ", "Z", " \overline{Z} ", "1", or "O" according to the data processing rusult. The value specified by the function is set to the flag with the mark "*", and the mark "-" denotes no change in the state of the flag.

Note 2. The zero flag is set according to the data set in the accumulator.

- Note 3. The flags (ZF, SF) are set according to the result of increment or decrement of the L register.
- Note 4. The carry is the data shifted out from the accumulator.
- Note 5. The contents of the program counter indicate the next address of the instruction to be executed.



TMP47C40P TMP47C20P *REIMINARY



TECHNICAL DATA

ELECTRICAL CHARACTERISTICS

ABSOLUTE MAXIMUM RATINGS $(V_{SS} = 0V)$

SYMBOL	ITEM	RATING	UNIT
VDD	Supply Voltage	-0.5 ∿ 7	v
VIN	Input Voltage	$-0.5 \sim V_{DD} + 0.5$	v
VOUT1	Output Voltage (Except open drain terminal)	$-0.5 \sim v_{DD} + 0.5$	
V _{OUT2}	Output Voltage (Sink open drain terminal)	-0.5 ~ 10	v
V _{OUT3}	Output Voltage (Source open drain terminal)	-35 ∿ VDD + 0.5	
PD	Power Dissipation (Topr=70°C)	600	mW
Tsld	Soldering Temperature • Time	260 (10 sec.)	
Tstg	Storage Temperature	- 55 ∿ 125	°C
Topr	Operating Temperature	-30 ~ 70	

RECOMMENDED OPERATING CONDITIONS $(V_{SS} = 0V)$

SYMBOL	ITEM	CONDITION	MIN.	MAX.	UNIT
Topr	Operating Temperature		-30	70	°C
VDD	Supply Voltage		4.5	6	v
VDDH	Supply Voltage (Hold)		2	6	v
VIH1	Input High Voltage (Except Schmitt circuit input) [Note 1]	W> / EW	V _{DD} x 0.7	VDD	
V _{IH2}	Input High Voltage (Schmitt circuit input)	V _{DD} ≥ 4.5V	V _{DD} x0.75	VDD	
V _{IH3}	Input High Voltage	V _{DD} < 4.5	$V_{DD} \ge 0.9$	VDD	v
VIL1	Input Low Voltage (Except Schmitt circuit input) [Note 1]		0	V _{DD} x 0.3	
V _{IL2}	Input Low Voltage (Schmitt circuit input)	VDD ≥ 4.5V	0	V _{DD} x0.25	
VIL3	Input Low Voltage	$V_{DD} < 4.5V$	0	VDD x 0.1]
VOUT	Output Voltage (Source open drain P1, P2, P4 \circ P6)		V _{DD} -35	V _{DD}	V
fc	Clock Frequency		0.4	4.2	MHz
tWCH	Clock High Pulse Width [Note 2]	$V_{IN} = V_{IH}$	80	-	
tWCL	Clock Low Pulse Width [Note 2]	$V_{IN} = V_{IL}$	80	-	ns

(Note 1) $R_4 \sim P_6$ ports are exclusively used for output except the sink open drain output.

(Note 2) In case of the external clock operation.



Toshiba

TMP47C40P TMP47C20P



TECHNICAL DATA

SYMBOL	Parameter	CONDITION	MIN.	Note 1 TYP.	MAX.	UNIT
V _{HS}	Hysteresis Voltage (Schmitt circuit input)		-	0.7	-	V
I IN1	Input Current (K0, RESET, HOLD, TEST) [Note 2]	V _{DD} =5.5V,	-	-	±20	
IIN2	Input Current (Sink open drain R port)	V _{IN} =5.5/0V	-	-	± 20	μ A
IIL	Input Low Current (Push-pull R ₇ ∿R ₉)	VDD=5.5V, VIN=0.4V	-	-	-2	mA
RIN	Input resistor (KQ with input resistor)		30	70	150	kΩ
IL01	Output Leak Current (Sink open drain P, R port)	VDD=5.5V, VOUT=5.5V	-	-	20	μA
ILO2	Output Leak Current (Source open drain P1,P2,R4 ∿R6)	VDD=5.5V, VOUT=-32V	-	-	20	μΑ
VOH1	Output High Voltage (Push pull R7 ∿ R9)	VDD=4.5V, IOH=-200µA	2.4	. –	-	
V _{OH2}	Output High Voltage (Source open drain P1, P2)	VDD=4.5V, IOH=-1.6mA	2.4	-	-	v
VOH 3	Output High Voltage (Source open drain R ₄ ∿ R ₆)	VDD=4.5V, IOH=-10mA	2.4	-	-	V
V _{OL}	Output Low Voltage (P, R port except source open drain)	V _{DD} =4.5v, IOL=1.6mA	-	-	0.4	
IDDO	Operating Supply VDD(VDDH)=5.5V, fC= N=5.3/0.2V	-	5	T.B.D	mA
IDDH	Holding Supply (all val Current [Note 3] CXIN=CXO	id) CL=50pF, UT=10pF	-	0.5	T.B.D	μA

D.C. CHARACTERISTICS ($V_{SS} = 0V$, $V_{DD} = 5V \pm 10\%$, Topr = $-30 \sim 70^{\circ}$ C)

(Note 1) TYP. values show those when Topr=25°C, V_{DD}=5V.

(Note 2) When the K_O port has a built-in input resistor, current by resistor is excluded.

(Note 3) When KO port has a built-in input resistor, current value is that at time of open. Further, voltage level at R port is valid.

A.C. CHARACTERISTICS

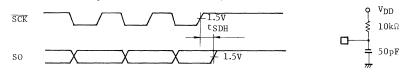
 $(VSS = 0V, VDD = 5V \pm 10\%, Topr = -30 \sim 70^{\circ}C)$

SYMBOL	Parameter	CONDITION	MIN.	TYP.	MAX.	UNIT
tcy	Instruction Cycle Time		3.8	-	40	μs
tSDH	Shift Data Hold Time	(Note 1)	0.5tcy-300	-	-	ns

A.C. TIMING CHART

• Serial Port (Completion of Transmission)

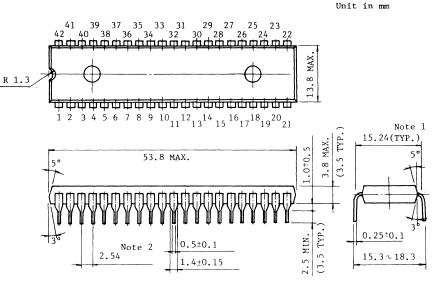
(Note 1) SCK, SO terminal external circuit





TMP47C40P TMP47C20P

EXTERNAL DIMENSION VIEW



Weight 5.7g (TYP.)

Note 1. This dimension is measured at the center of bending point of leads.

Note 2. Each lead pitch is 2.54mm, and all the leads are located within ± 0.25 mm from their theoretical positions with respect to No.1 and No.42 leads.



TMP47C40P TMP47C20P

PRELININARY

Specification of program tape and input/output circuit format

Engineering Samples(ES) of the TMP47C40P, TMP47C20P, TMP47C41P and TMP47C21P will be made if you specify the program data and input/output circuit format by use of a paper tape.

The paper tape format is equivalent to the Hex. format of Intel Co. (Format I).

The program data should be specified within the address space corresponding to the built-in ROM capacity: the addresses 000 - 7FF denote the address range in the TMP47C20P and TMP47C21P. Accordingly, if the PLA data conversion table (addresses FEO - FFF) is used, the table data must be assigned as the data located in addresses 7EO - 7FF.

1. Specification of input/output circuit format

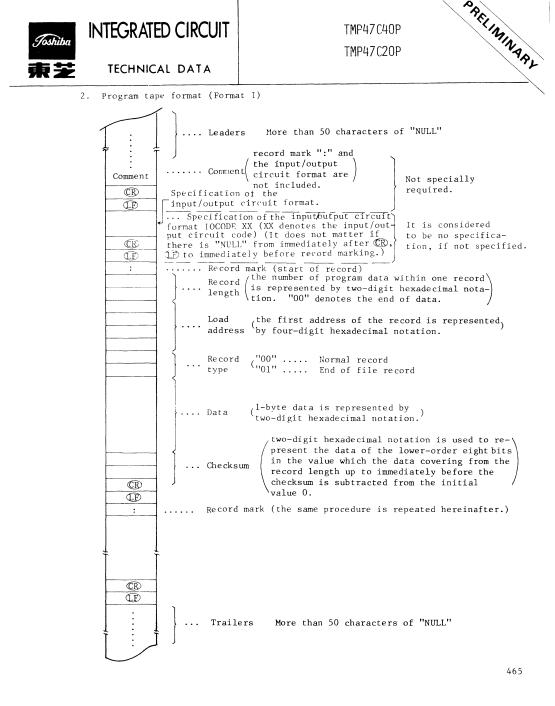
The paper tape of Format I starts recording the program data after record mark ":", but the input/output circuit code should be specified just before the first record mark.

The "IOCODE XX" format is used to define the input/output circuit code. XX denotes the proper input/output circuit code (two alphabets).

(Note) If the input/output circuit code is not specified, "IOCODE FA" OR "IOCODE HA" are employed. It should be noted that if the specified format is different from the standard one, and if the specified input/output circuit code is illegal, such specifications may be considered to have not been made.

(Example of tape list)

TOSHIBA MICROCOMPUTER TLCS-47 TOCODE FA :10000000665C7D79CF50F3F951FED55A8FF16E570 :1000100088884DDE67E31F5D8ABA6DF292F113F5C1 :100020004FF1F : : :1007E000B53D42E0EC32546025B7308CDD52063D1D :1007F000B4BE9E9E345B6138060B20BC372BF60BD6 :00000001FF





TMP47C40P

PREI ININA RY

TMP47C20P

LIST OF INSTRUCTIONS

ltem			Object Code					×1	rcle]
	Assembler	Bina	ry	Hexad	ecimal	Function	Fla	ags	Ltton C S	
C lassi- fication	Mnemonic	lst Byte	2nd Byte	lst Byte	2nd Byte		CF	ZF SF	Exect	
1	LD A,@HL	00 00 11 00		oc		(AC)↔M[((I+L)]	-	Z 1	1	
	LD A, X	00 11 11 00	x7x6x5x4x3x2x1x0	зс	х _Н х _L	(AC)↔M[x]	-	2 l	2	
l	LD HL, X	00 10 10 00	x ₇ x ₆ x ₅ x ₄ x ₃ x ₂ x ₁ x ₀	28	х _Н х _L	$(LR) \leftarrow M[x'], (HR) \leftarrow M[x+1], x'=x_7x_6x_5x_4x_3x_200$	4-	- 1	2	
	LD A,#k	01 00 k3k2k1k	0	4 k		(AC) ↔k	-	Z 1	1	
1	LD H,#k	11 00 k3k2k1k	0	CK		(HR) ←k	-	- 1	1	
	LD L ,# k	11 10 k3k2k1k	0	E k		(LR)↔k	-	- 1	1	
	LDL A ,@DC	00 11 00 11		3 3		(AC) ← BOML[(DC)]	-	Ζ 1	2	
	LDH A ,@DC+	00 11 00 10		32		$(AC) \leftarrow ROM_{H} [(DC)], (DC) \leftarrow (DC)+1$	-	Z 1	2	*2
	ST A ,@HL	00 00 11 11		0 F		M[(H•L)]←(AC)	-	- 1	1	1
1	ST A ,@HL+	00 01 10 10		1 A		$M[(H \cdot L)] \leftarrow (AC), (LR) \leftarrow (LR) + 1$	-	Z Ĉ	1	*3
	ST A ,@HL	00 01 10 11		18		$M[(H \cdot L)] \leftarrow (AC), (LR) \leftarrow (LR) - 1$	-	ΖB	1	*3
ø	ST A,X		x7x6x5x4x3x2x1x0	3 F	XHXL	M[x] ← (AC)		- 1	2	
Move	ST #k,@HL+	l] 11 k3k2k1k		Fk		$M[(H \cdot L)] \leftarrow k, (LR) \leftarrow (LR) + 1$	-	7, Ĉ	1	*3
	st #k,y		k ₃ k ₂ k ₁ k ₀ y ₃ y ₂ y ₁ y ₀	2 D	k y	M[y] ← k		- 1	2	
	MOV H, A	00 01 00 00		10		$(AC) \leftarrow (HR)$	-	Ζ 1	1	
	MOV L, A	00 01 00 01		11		(AC)←(LR)	-	2 1	1	1
	XCH A, H	00 11 00 00		30		(HR) ≓ (AC)	-	Ζl	2	*2
	XCH A, L	00 11 00 01		31		(LR) ≓ (AC)	-	Ζ 1	2	*2
	XCH A ,EIR	00 01 00 11		13		(EIR) ≓ (AC)	-	- 1	1	
	XCH A ,@HL	00 00 11 01		0 D		$M[(H \cdot L)] \rightleftharpoons (AC)$	-	Z 1	1	*2
	XCH A, X		x ₇ x ₆ x ₅ x ₄ x ₃ x ₂ x ₁ x ₀	3 D	х ^н хг	M[x] ≓ (AC)	-	Ζ 1	2	*2
	XCH HL, X		x ₇ x ₆ x ₅ x ₄ x ₃ x ₂ x ₁ x ₀	2 9	×нхг	$M[x'] \rightleftharpoons (LR), M[x'+1] \rightleftharpoons (HR), x' \Rightarrow x_7 x_6 x_5 x_4 x_3 x_2 00$		- 1	2	
	CMPR A ,@HL CMPR A , X	00 01 01 10		16 3E		$\operatorname{null} \leftarrow M[(H \cdot L)] - (AC)$	Ē	Z Z Z Z	1	
e L	CMPR A, X	1	x ₇ x ₆ x ₅ x ₄ x ₃ x ₂ x ₁ x ₀	Dk	×нхг	$mull \leftarrow M[x] - (AC)$	B	ZZ	2	
Compare	CMPR H,#K	11 01 k ₃ k ₂ k ₁ k	0 11 01 k3k2k1k0	38	Dк	$null \leftarrow k - (AC)$ $null \leftarrow k - (HR)$	в	ZB	2	
Com	CMPR L,#K		10 01 k3k2k1k0	38	9 k	$null \leftarrow k - (LR)$	-	ZB	2	
	CMPR y,#k		k ₃ k ₂ k ₁ k ₀ y ₃ y ₂ y ₁ y ₀	2 E	k y	null←k –M[y]	B	2 B 2 Z	2	
	INC A	00 00 10 00		08		$(AC) \leftarrow (AC) + 1$	-	2 C	1	1
	INC L	00 01 10 00		18		$(LR) \leftarrow (LR) + 1$	_	zc	1	
	INC @HL	00 00 10 10		0 A		M[(H•L)]↔M[(H•L)]+1	_	zē	1	
	DEC A	00 00 10 01		0 9		$(AC) \leftarrow (AC) - 1$	-	ZB	1	1
	DEC L	00 01 10 01		19		(LR)←(LR) - 1	_	7, B	.1	
	DEC @HL	00 00 10 11		ОВ		M[(H•L)]←M[(H•L)]-1	-	zΒ	1	
10	ADDC A ,@HL	00 01 01 01		15		$(AC) \leftarrow (AC) + M[(H \cdot L)] + (CF)$	С	2 C	1	1
le t	ADD A ,@HL	00 01 01 11		17		$(AC) \leftarrow (AC) + M[(H \cdot L)]$	_	zē	1	
Arithmetic	ADD A,#k	00 11 10 00	00 00 k3k2k1k0	38	Οĸ	$(AC) \leftarrow (AC) + k$	-	z č	2	
11/	ADD H,#k	00 11 10 00	11 00 k ₃ k ₂ k ₁ k ₀	38	Ck	$(HR) \leftarrow (HR) + k$		z T	2	
	ADD L,#k		10 00 k3k2k1k0	38	8 K	$(LR) \leftarrow (LR) + k$	-	z ĉ	2	
	ADD @HL,#k		01 00 k ₃ k ₂ k ₁ k ₀	38	4 k	M[(H•L)]←M[(H•L)] + k	-	z ĉ	2	
	ADD y,#k	00 10 11 11	k ₃ k ₂ k ₁ k ₀ y ₃ y ₂ y ₁ y ₀	2 F	ky	M[y]←M[y]+k	-	ΖĈ	2	
	SUBRC A ,@HL	00 01 01 00		14		$(AC) \leftarrow M[(H \cdot L)] - (AC) - \overline{(CF)}$	B	ΖB	1	
	SUBR A ,#k		00 01 k3k2k1k0	38	l k	$(AC) \leftarrow k - (AC)$		Z B	2	
	SUBR @HL,#k		01 01 k3k2k1k0	38	5 k	$M[(H \cdot L)] \leftarrow k - M[(H \cdot L)]$		ΖĒ	2	1
	ROLC A	00 00 01 01		05		CF AC (rotate left by 1 bit)		z c	1	*4
	RORC A	00 00 01 11		07		AC CF (rotate right by 1 bit)	С	z ĉ	1	*4
_	AND A ,@HL	00 01 11 10		1 E		(AC) ← (AC) ∧ M[(H•L)]		ZZ	1	
Logical	AND A,# K		00 11 k3k2k1k0	38	3 k	(AC)←(AC)∧k	-	Z Z	2	
180	AND @HL,#k OR A,@HL	00 11 10 00	01 11 k3k2k1k0	38 1D	7 k	$M[(H \cdot L)] \leftarrow M[(H \cdot L)] \land k$ $(AC) \leftarrow (AC) \lor M[(H \cdot L)]$	-	ZZ	2	1
-	OR A,@HL		00 10 k3k2k1k0	1 D 3 8	2 k	$(AC) \leftarrow (AC) \lor M[(H \cdot L)]$ $(AC) \leftarrow (AC) \lor k$		ZZ	1	
	OR CHL,#K		01 10 k3k2k1k0 01 10 k3k2k1k0	38	2 K 6 K	$(AC) \leftarrow (AC) \lor k$ $M[(H \cdot L)] \leftarrow M[(H \cdot L)] \lor k$		ZZ	2	
	XOR A ,@HL	00 01 10 00	VI IU N3K2E1K0	38 1F	- × -	$(AC) \leftarrow (AC) \forall M[(H \cdot L)] \lor K$	-	2 2	2	ł
L	non n jon	00 01 11 11		1 .		(WA), (WA) & WE(U,P)]		<u> </u>	1-	1



TMP47C40P

*RELIMINARY

TMP47C20P

(continued)

Item			Object Code				F1:	*1 gs	a de
L	Assembler	Bina	ary	Hexad	iecımal	Function			ut1 CV0
Classi- fication	Mnemonic	lst Byte	2nd Byte	lst Byte	2nd Byte		CF	ZF SF	Execution
	TEST CF	00 00 01 10		0 6		$(SF) \leftarrow (\overline{CF}), (CF) \leftarrow 0$	0	- *	1
	TEST A, b	01 01 11 b _l b	90	5 C +	ъ	$(SF) \leftarrow \overline{AC} \overline{\langle AC \rangle}$		- *	1
	TEST @HL, b	01 01 10 b ₁ t	0	58+	b	$(SF) \leftarrow \overline{M[(H \cdot L)] \times b}$		- *	1
	TEST y, b		10 b ₁ b ₀ y ₃ y ₂ y ₁ y ₀	3 9		$(SF) \leftarrow \overline{M[y] \langle b \rangle}$	-	- *	2
	TEST %p , b	00 11 10 11	10 b ₁ b ₀ p ₃ p ₂ p ₁ p ₀	3 E	18+p b	$(SF) \leftarrow \overline{P[p] \langle b \rangle}$	-	- *	2
	TEST @L	00 11 01 11		3 7		$(SF) \leftarrow P[(LR) < 3:2>+4] < (LR) < 1:0>>$	~	- *	2
	TESTP CF	00 00 01 00		0 4		$(SF) \leftarrow (CF), (CF) \leftarrow 1$	1	*	1
	TESTP ZF	00 00 11 10		0 H	;	$(SF) \leftarrow (ZF)$	-	- *	1
	TESTP OF	00 00 00 01		01		$(SF) \leftarrow (GF)$	-	- *	1
ion	TESTP y , b		ll b ₁ b ₀ y ₃ y ₂ y ₁ y ₀	3 \$			-	- *	2
pulation	TESTP %p. b	00 11 10 11	11 b1b0p3p2p1p0	3 E	С+6 р			- *	2
[nd	SET GF	00 00 00 11		0 3		(0F) ← 1	-	- 1	1
Mani	SET @HL, b	01 01 00 b ₁ t	-	5 t		M[(H•L)] ←1	-	- 1	1
Me	SET y,b		00 b1b0333534130	3 S	b y	M[y] ← 1	-	- 1	2
t.	SET %p,b	00 11 10 11	00 b1b0b3b2b1b0	3 E	s b p	P[p] ← 1	-	- 1	2
Bı	SET @L	00 11 01 00		34		P[(LR)<3:2>+4]<(LR)<1:0>>←1	-	- 1	2
	CLR OF	00 00 00 10		0 2		(GF) ← 0	-	- 1	1
	CLR @HL, b	01 01 01 b ₁ t	0	54+	-b	M[(H+L)] ←0	-	- 1	1
	CLR y,b	00 11 10 01	01 b ₁ b ₀ y ₃ y ₂ y ₁ y ₀	3 9	9 4+b y	M[y] ← 0		- 1	2
	CLR %p,b	00 11 10 11	01 b ₁ b ₀ p ₃ p ₂ p ₁ p ₀	3 E	4+b p	P[p] ←0	-	- 1	2
	CLR @L	00 11 01 01		3 5		P[(LR)<3:2>+4]<(LR)<1:0>>←0	-	- 1	2
	CLR IL, r		ll r5r4r3r2r1r0	3 θ	C+r _H r _L	(1NTL)<5:0>←(1NTL)<5:0>\r<5:0>	-	- 1	2
	BICLR IL , r	00 11 01 10	01 r5r4r3r2r1r0	3 E	a+rHrL	(EIF)←1,(INTL)<5:0>←(INTL)<5:0>∧r<5:0>	-	- 1	2
	DICLR IL , r	00 11 01 10	10 r5r4r3r2r1r0	3 E	8+rHrL	(EIF)←0,(INTL)<5:0>←(INTL)<5:0>/r<5:0>	-	- 1	2
	IN %p,A	00 11 10 10	00 10 p3p2p1p0	3 A	. 2 p	$(AC) \leftarrow P[p]$	-	ΖĪ	2
put	1N %p,@HL	00 11 10 10	01 10 p3p2p1p0	3 A	6 P	M[(H•L)]←P[p]		- Z	2
out	0UT A ,%p	00 11 10 10	10 p40 p3p2p1p0	3 A	8+274p	$p[p] \leftarrow (AC)$, $p = p_4 p_3 p_2 p_1 p_0$	-	- 1	2
2	OUT @HL,%p	00 11 10 10	$11 \ \overline{p_4}0 \ p_3 p_2 p_1 p_0$	3 /	C+2p4p	$p[p] \leftarrow M[(H \cdot L)], p = p_4 \cdot p_3 p_2 p_1 p_0$	-	- 1	2
Input/Output	оυт # k ,%p	00 10 11 00	$k_{3}k_{2}k_{1}k_{0}p_{3}p_{2}p_{1}p_{0}$	2 0	k p	p[p] ← k	-	- 1	2
=	OUTB @HL	00 01 00 10		1 2		$P[2] \cdot P[1] \leftarrow ROM[F \cdot (E+(CF)) \cdot M[(H \cdot L)]]$	-	- 1	2
	BS a	01 10 a ₁₁ a ₁₀ a ₉ a	18a7a6a5a4a3a2a1a0	6 a	H aM aL	If SF=1 then(PC)←a else null.	-	- 1	2
ne	BSS a	10 d5d4d3d2d1	d ₀	8+d _H	αL	If SF=1 then(PC)←a else null,a=(PC)<11:6>d		- 1	1
Branch•Subroutine	CALL a	00 10 0a ₁₀ a ₉	a ₈ a ₇ a ₆ a ₅ a ₄ a ₃ a ₂ a ₁ a ₀	2 a	H ^a M ^a L	$STACK[(SPW)] \leftarrow (PC), (SPW) \leftarrow (SPW) - 1$,	-		2
oro						(FC)←a,0∠a∠2,047			
Sut	CALLS a	Ol ll n ₃ n ₂ n ₁ r	10	7 r		$STACK[(SPW)] \leftarrow (PC), (SPW) \leftarrow (SPW)-1,$	-		2
i.						(PC)←a,a=8n+6(n≒0),134(n=0)			
anc	RET	00 10 10 10		2 A		$(SPW) \leftarrow (SPW) + 1$, $(PC) \leftarrow STACK[(SPW)]$			2
Bri	RETI	00 10 10 11		2 E	3	(SPW) ← (SPW) + 1 , (FLAG•PC) ← STACK[(SPW)]	*	* *	2
						(£IF)←1			
Other	NOP	00 00 00 00		0 0		no operation	-		1
ö	1	l					l		L

Note 1. Setting Condition of Flag.

Contractions of the series of the second sec

Note 2 The zero flag is set according to the data set in the accumulator. Note 3 The flags(2F,BF)are set according to the result of increment or decrement of the L register.

NOte 4. The carry is the data shifted out from the accumulator.

Note 5. The contents of the program counter indicate the next address of the instruction to be executed.

TMP47C40P TMP47C20P

Laghun 1340

(cont	inued)
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Ope	atn	JII 01	040	an up													Continued	. ,				
lover higher	0	1	2	3	4	5	6	7	8	9	A	в	с	D	в	P	lst byte code 2nd byte code(higher)		0P38 38	0P39 39	OP3A 3A	0 P3 B 3 B
0	NOP	TESTE	CLR GF	SET GF	TESTR	ROLC	TEST CF	RORC	I NC	DEC	INC @HL	DEC @HL	LD A.@HI	XCH	TESTF	ST A,@HL	0		ADD A, #k			
1		MOV L,A	OUTE @HL	AEIR	SUBRC A,@HL		CMPR A,@HL		INC	DBC	ST	ST A,@HL-		OR	AND	XOR A,@HL	1		SUBR A, #k			
2					L a				LD	XCH HL,X	RET	RETI	OUT	ST	CMPR y,#k	ADD	2		OR A, #k	SET y, b	IN %p,A	SET %p,b
3	хсн А,Н	XCH A,L	LDH A@DCH			CLR @L	(OP36)	TEST @L	(OP38)	(op39)	(OP3A)		LD	хсн 🔪	CMPR A,X	ST Y	3		AND A, #k			
4							• 1	LD A,	#k								4		ADD @HL, #k			
5		SET @	нL, b			CLR @	HL,b		1	TEST @	HL,b			TEST	A,b		5	EICIR	SUBR @HL, #k	CLR		CLR
6								BS	a								6	ıL,r	0R @HL, #k	y, b	IN %ap,@HL	%p,b
7								CAL	Ls a								7		AND @HL, #k	·		
8																	8		ADD L, #k CMPR		OUT A,%p	
9								BSS	а								9	DICIR IL,F	L, #k	TEST	OUT	TEST %p,b
A																	Α	15,1		y, b	А,%р	, ≫p,b
В																	В		ADD		OUT	
c								LD		⊣, #k							C		H, #k	TESTP	@HL,%p	TESTP
D								CMPI		⊾, #k							D	CLR IL, r	н, #k	y, b	OUT	%p,b
E								LD		ւ, #k							E				@н∟,%р	
F								ST	#	к, @н	L+						F					

(caution)

Operation Code Map

1. Blank codes are reserved.

2. _____ is indicated 2-byte instruction.